# Studies on defect and contact properties of ZnSnP<sub>2</sub> for application to thin film photovoltaics

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# **1.** General introduction

# 1.1. Solar cell — an essential power generation for sustainable society—

After the innovation of steam engines through the Industrial Revolution in the 18th century, human beings have consumed a tremendous amount of coal, petroleum, and natural gas for power generation and emitted a corresponding amount of carbon dioxides ( $CO_2$ ). Although it has been a long time since it was pointed out that the content of  $CO_2$  in the atmosphere is one of the main factors on global warming, many countries still rely on thermal power generation, as shown in Figure 1-1, because of lower cost than other techniques [1–3]. As declared in the 17 Sustainable Development Goals (SDGs) of the United Nations [4], it is urgent to develop and spread cheaper and cleaner power generation techniques.

Alternative sources to fossil fuels are nuclear power, wasted energy like biomass and heat, and renewable energy like wind, tidal, hydro, geothermal, and solar powers [5]. Considering the total energy of solar irradiation on the earth is 7000–8000 times larger than the world energy consumption [5,6], solar power can be the stem of sustainable society. In addition, solar cells can be



Figure 1-1. Global primary energy consumption by source [3].

used for various purposes and situations; for portable devices and vehicles such as cars, aircrafts, and satellites; at remote places such as islands, highlands, deserts, and space; and in emergencies where electrical supply shuts down. Such substantial usefulness of solar cells is indispensable to follow the increasing demands for electricity in the movement toward the IoT society and to struggle with the increase in natural disasters resulting from climate changes.

# **1.2.** Principles of photovoltaic conversion in solar cells

Solar cells are devices that directly convert optical energy to electricity. As schematically shown in Figure 1-2, compound-based solar cells typically consist of multi-layers with various properties, indicating the importance of combinations of materials. It is necessary to understand photovoltaic (PV) conversion principles in solar cells and the properties expected for each layer.



Figure 1-2. Schematic illustration of typical solar cells based on compounds.

# 1.2.1. Light absorption and carrier generation

The PV conversion process in solar cells can be divided roughly into two steps; carrier generation and transport. At first, incident light absorbed by solar cells generates free carriers with a specific rate determined mainly by the relationship of the flux and wavelength of the incident light and the absorption coefficient and the bandgap of the absorption layer. A high absorption coefficient leads to a high carrier generation and high PV conversion efficiency for the same absorber thickness.

On the other hand, the maximum current and voltage are trade-offs at a specific bandgap: a small bandgap leads to a large current but small voltage, while a large bandgap leads to a large voltage but small current. It leads to the well-known Shockley-Qeuisser theory, which quantitatively describes the relationship between bandgap of absorption layers and PV conversion efficiencies of solar cells [7]. For example, theoretical efficiencies are over 30% in the range of the bandgap between 1.0 - 1.6 eV as shown in Figure 1-3 under the sunlight of air-mass 1.5 global tilt (AM 1.5G) [7,8]. Choosing an absorber material with a high absorption coefficient and suitable bandgap to the subjected incident light spectrum is crucial.



Figure 1-3. (a) Relationship between conversion efficiency of solar cells and bandgap of absorber layers calculated based on Shockley-Queisser theory and (b) spectrum irradiation of sunlight under AM 1.5G.

# 1.2.2. Carrier transport

Photo-generated carriers need to be transported to external circuits without any loss as possible. Usually, one incident photon generates one pair of negative and positive carriers, called an electronhole pair. The photo-generated carriers with high kinetic and potential energy enough to overcome Coulomb attraction can diffuse in certain distances. The distance and period until recombination, called carrier diffusion length and lifetime, respectively, are favorable to be long for carrier transport. It is vital to reduce defects that may scatter or trap carriers, hinder carrier diffusion, and decrease the extraction of electricity. Such defects may exist not only in intra-layers but also at interfaces.

# 1.2.3. Equivalent circuit and diode equation of solar cells

If there is only an isotropic electric field around an absorption media, photo-generated carriers diffuse in random directions, and the net electrical current becomes zero. Generally, *pn* diodes are used to generate a unidirectional electric field and assist the separation of carriers with negative and positive charge diffusing in opposite directions. An equivalent circuit of solar cells are described as shown in Figure 1-4 (a). The relationship between current density and voltage in solar cells are usually expressed by a modified diode equation [9];

$$J = -J_0 \left[ \exp\left(\frac{q(V - R_{\rm s}J)}{nkT}\right) - 1 \right] + \frac{V - R_{\rm s}J}{R_{\rm sh}} + J_{\rm ph} , \qquad (1-1)$$

where  $J_0$ ,  $J_{ph}$ , n,  $R_s$ ,  $R_{sh}$  are reverse saturation current density, photo-generated current density, ideality factor, series resistance, and shunt resistance, respectively. k, q, T are the Boltzmann constant, elementary charge, and absolute temperature, respectively. Figure 1-4 (b) shows typical current density-voltage (*J-V*) characteristics under dark and illuminated conditions. The following equation



Figure 1-4. (a) Equivalent circuit of solar cells with diode parameters described and (b) *J-V* characteristics under dark and illuminated conditions and device parameters of solar cells.

determines PV conversion efficiency (PCE);

$$PCE = \frac{J_{\max} \cdot V_{\max}}{W_{\text{photo}}} = \frac{J_{\text{SC}} \cdot V_{\text{OC}} \cdot FF}{W_{\text{photo}}}, \qquad (1-2)$$

where the product of  $J_{\text{max}}$  and  $V_{\text{max}}$  is the maximum operating point,  $P_{\text{max}}$  in Figure 1-4 (b).  $P_{\text{max}}$  is also expressed by another product of  $J_{\text{SC}}$ ,  $V_{\text{OC}}$ , and FF: the short-circuit current density, open-circuit voltage, and fill factor.  $W_{\text{photo}}$  is the power of incident light per unit area.  $J_{\text{sc}}$ ,  $V_{\text{oc}}$ , and FF are the most frequently used parameters to evaluate the performance of solar cells.

# 1.3. Solar cells based on inorganic absorber materials

Figure 1-5 shows a classification tree of the adamantine family of compound semiconductors [10], where Roman numerals represent the number of valence electrons. Various adamantine compounds are derived from group IV elements by replacing one with two elements with



Figure 1-5. Classification tree of adamantine family of compounds [10].

	С	ell	Module		
	PCE / %	Area / cm <sup>2</sup>	PCE / %	Area / cm <sup>2</sup>	
Si mono-crystalline	26.7	79	24.4	13177	
Si multi-crystalline	24.4	268	20.4	14818	
GaAs	29.1	0.998	-	-	
CIGS	23.4	1	19.2	841	
CdTe	21	1	19	23573	
Perovskite	22.6	1	17.9	804	

Table 1-1. PCE and areas of various solar cells and modules [11].

keeping the number of nominal valence electrons per atom at four. As named adamantine, many compounds have diamond-like crystal structures such as sphalerite-, chalcopyrite-, and kesterite-types. Absorber materials used in the PV industry like Si, GaAs, InP, CuInSe<sub>2</sub>, and CdTe are all included in this family.

# 1.3.1. Commercial materials

Table 1-1 shows PCE of several types of solar cells and modules [11]. Since the first PV conversion with *pn*-junction was reported on Si-based solar cells by Chapin, Fuller, and Pearson in the 1950s [12], various types of solar cells using monocrystalline, polycrystalline, and amorphous Si have been developed. Continuous researches over 60 years push up the PCE of Si solar cells more than 26% [13,14]. Accordingly, the PCE of modules sold by the ten biggest PV companies worldwide is higher than 20%, and Si-based solar cells occupy 95% of the world PV production [15].

III-V compounds like GaAs, InP, and their alloys have been studied for several decades. The efficiencies of III-V based single-junction solar cells are higher than 29% [16]. Although the high process cost limits their use in high-efficiency tandem or concentrated solar cells for the space industry [17], the highest efficiency of 47.1% was reported for 6-junction tandem solar cells under the direct spectrum at 143 Suns concentration [18].

Solar cells based on thin-film CuInSe<sub>2</sub> (CIS) and CdTe have been intensively researched because their high absorption coefficients and lightweights make it possible to cover the installation limit of Si-based solar cells, as the highest PCE of CIS- and CdTe-based solar cells are 23.35% [19] and 22.1% [20], respectively. Recently, the share of CdTe solar cells in the annual world products of thin-film solar cells has been growing and has become 78% until 2020 [15]. Further demands for thin-film PVs can be expected in the near future because vast lands for mega-solar systems are limited, and solar cells will need to be installed on other places such as roofs, walls, vehicles, etc.

N - + 1	PCE	Voc	$J_{ m SC}$	FF	Davis a structure
Material	/ %	/ V	$/ \text{ mA cm}^{-2}$	/ %	Device structure
Cue7n8n8 (C7T8)	11	0.731	21.74	60.2	Glass/Mo/CZTS/CdS/
$Cu_2ZII3II34$ ( $CZI3$ )	11		21.74	09.5	i-ZnO/ITO/Al/MgF2
Cua7nSn(SaarSaara) (C7TSSa)	12.6	0.512	35.2	69.8	Glass/Mo/CZTSSe/
Cu22II3I(30.253C0.75)4 (CZ153C)	12.0	0.515			CdS/ZnO/ITO/Ni/Al/MgF2
$Cu_27nSn(S_Se_1)_4$ (C7TSSe)	12.62	0.541	35 35	65.0	Glass/Mo/CZTSSe/CdS/
$Cu_2 Zii3ii(SySe_1-y)_4 (CZ 15Se)$	12.02	0.541	55.55	05.9	ZnO/ITO/Ni/Al/MgF <sub>2</sub>
$Cu_{2}7nSnSe_{4}(C7TSe)$	12.5	0.491	37 37	68 2	Glass/Mo/CZTSe/CdS/ZnO/
	12.5	0.471	57.57	00.2	AZO/Ni/Al/MgF2
$O_{-1}D$ Sha(S Se)	10	65.5	24.07	63 5	Glass/FTO/CdS/Sb <sub>2</sub> Se <sub>3</sub> /
Q 1D 502(5,50)3	10			05.5	Spiro-OMeTAD/Au
Cu <sub>2</sub> ZnCdSnS4	12.6	0.64	27.8	71	Glass/Mo/CZCTS/CdS/
	12.0			/1	ITO/Ag
$(A_{50,05,0,2}C_{110,05,0,7})$ , $ZnSn(S,Se)$	11.2	0 464	36.2	66 5	Glass/Mo/ACZTSSe/CdS/
(1 <u>5</u> 0.03–0.3 C <b>0</b> 0.53–0.7)2211011(0,0 C)4	11.2	0.101	50.2	00.5	ZnO/ITO/Ag
(Ago osCilo os)2(Zno 75Cdo 25)S4	10.1	0.65	23.4	66.2	Glass/Mo/ACCdZTS/CdS/
(1 1 20.05 0 40.95)2(22.0.75 0 40.25)24	1011	0.00	2011	00.2	ITO/Ag
$Cu_2Zn(Sn_0.78Ge_0.22)Se_4$	12.3	0.527	32.2	72.7	Glass/Mo/CZTGTSe/CdS/
	12.0	0.527	02.2		ZnO/AZO/Ag/ARC
$(Li_{0.05}Cu_{0.04})_2ZnSn(S.Se)_4$	11.6	0.531	33.7	64.8	Glass/SiOx/Mo/LiCZTSSe/
(=-0.00 = -0.04)2=(9=-94			55.7		CdS/ZnO/AZO/Ni/Al/MgF <sub>2</sub>
$Cu_2ZnSn_rGa_{1-r}(S.Se)_4$	10.8	0.455	36.48	65.05	Glass/Mo/CZTGSSe/CdS/
	- 0.0	5	2 3 0	50.00	iZnO/ITO/Ag/MgF2
Q-1D Sb <sub>2</sub> (S <sub>x</sub> Se <sub>1-x</sub> ) <sub>3</sub>	10.5	0.664	23.8	66.3	$Glass/FTO/Sb_2(S_xSe_{1-x})_3/Au$

Table 1-2. Device parameters of emergent inorganic solar cells with PCE > 10%.

# 1.3.2. Emerging inorganic absorbers

Scientists are now eagerly exploring emerging absorber materials without expensive and toxic elements like Ga, In, Se, Cd, and Te in Cu(In,Ga)Se<sub>2</sub> and CdTe for further spreading of solar cells. This section briefly introduces studies on emerging inorganic absorbers of chalcogenides and pnictides. Table 1-2 summarized emergent inorganic solar cells with PCE > 10% referred to [21]. Analog materials to lead-halide perovskites are mentioned elsewhere [22].

#### Chalcogenides

In ref [21], half of the listed emerging materials are chalcogenides. Especially, I<sub>2</sub>-II-IV-VI<sub>4</sub> group materials, which are close to well-established I-III-VI<sub>2</sub> materials like CuInSe<sub>2</sub>, have been intensively studied by substituting or alloying. Solar cells based on Cu<sub>2</sub>ZnSn(S,Se)<sub>4</sub> (CZTSSe), a solid

solution of  $Cu_2ZnSnS_4$  and  $Cu_2ZnSnSe_4$ , showed the highest efficiency of 12.6% in chalcogenides [23,24]. Quasi one-dimensional (Q-1D) antimony-based chalcogenides like Sb<sub>2</sub>S<sub>3</sub>, Sb<sub>2</sub>Se<sub>3</sub>, and Sb<sub>2</sub>(S,Se)<sub>3</sub> alloy have recently attracted much attention as one of low-dimensional absorbers and the PCE is of 7–10% [25–29].

# Pnictides

In contrast to chalcogenides, applications of novel pnictides to solar cells are very few. Even for Zn<sub>3</sub>P<sub>2</sub>, a relatively famous pnictide in the above review, there are only 12 reports on solar cell applications [30]. In other words, pnictides are frontier worth exploration to expand materials diversity. Similar to the relation between II-VI and I-III-VI<sub>2</sub> groups, there are II-IV-V<sub>2</sub> group materials that are derivatives from III-V compounds by replacing III to II and IV elements. II-IV-V<sub>2</sub> group materials were reviewed at first by Shay and Wernick about 60 years ago [31]. Recently, the research group of Tamboli pointed out their tunability of lattice constants and bandgaps alloying and utility for photovoltaic devices [32,33].

# 1.4. Overview of the previous studies on ZnSnP<sub>2</sub>

ZnSnP<sub>2</sub>, the subject material of this study, is one of the II-IV-V<sub>2</sub> materials without toxic and expensive elements. Since Goodman reported the synthesis of ZnSnP<sub>2</sub> in 1957 [34], ZnSnP<sub>2</sub> has been studied mainly by the groups in Ioffe Institute, Texas University, and Kyoto University. In this chapter, the previous studies on ZnSnP<sub>2</sub> are overviewed with focusing on physical properties, structural analysis, growth methods, and applications.

### **1.4.1.** Physical properties

In 1968, Vaipolin et al. reported that ZnSnP<sub>2</sub> has two modifications, chalcopyrite ( $I\overline{4}2d$ 

5.651 Å, c/a = 2) and sphalerite ( $F\overline{4}3m$ , a = 5.651 Å, c/a = 1) types as shown in Figure 1-6 (a) and (b) [35]. The Wyckoff positions of Zn, Sn, and P atoms are 4a, 4b, and 8d, respectively. A parameter *X*, which is used for the description of the position of P atoms, equals 0.238 for chalcopyrite and 0.25 for sphalerite.

It is commonly reported that  $ZnSnP_2$  is an intrinsically p-type semiconductor. For small crystals grown by simply cooling the solution in Sn flux, carrier density and mobility are usually about  $10^{16}-10^{18}$  cm<sup>-3</sup> and 5–50 cm<sup>2</sup> V<sup>-1</sup> s<sup>-1</sup>, respectively [35–39]. According to Nakatsuka et al., those s of large bulk crystals of nearly  $10 \times 10 \times 1$  mm<sup>3</sup> in dimensions are  $6 \times 10^{16}-2 \times 10^{17}$  cm<sup>-3</sup> and 1-3 cm<sup>2</sup> V<sup>-1</sup> s<sup>-1</sup> [40], which is suitable values for the absorber of solar cells.

Goryunova et al. reported, based on the analysis of band-structure, that the fundamental absorption is associated with the direct transition between the valence band (VB) and the conduction band (CB) at the  $\Gamma$  point in the **k**-space [37]. According to the first principles calculation by Yokoyama et al., the absorption coefficient of ZnSnP<sub>2</sub> is more than 10<sup>4</sup> cm<sup>-1</sup> in the range of photon energy above 1.8 eV, which is comparable to other compound absorber materials like GaAs, CdTe, and Cu(In,Ga)Se<sub>2</sub> [41].

Berkovskii et al. measured cathode-luminescence (CL) spectra for ZnSnP<sub>2</sub> grown with a low cooling rate and observed the radiative recombination (RR) with the energy of 1.46 eV [42]. They attributed this CL to the band-to-band (BB) transition. Kradinova et al. observed the RR from donor-



Figure 1-6. (a) Sphalerite- and (b) chalcopyrite-type ZnSnP<sub>2</sub>.

to-acceptor (DAP) transition only for  $ZnSnP_2$  grown with a high cooling rate during crystallization from Sn -solution [43]. They also confirmed the decrease of the RR from DAP transition and the blueshift of the RR from BB transition by heat treatment at 870–1050 K. They concluded the heat treatment led to the decrease of the donor and acceptor densities, supposing the DAP come from cation antisites. Nakatsuka et al. observed photoluminescence (PL) at 1.69 eV for ZnSnP<sub>2</sub> grown by unidirectionally cooling Sn-solution with a cooling rate of 0.7 °C h<sup>-1</sup> [44], which is much slower than that employed by Berkovskii et al. [42].

Nakatsuka et al. also reported a fast decay of time-resolved PL (TRPL) spectra, indicating more than 99% of photo-generated minority carriers drop from the CB to other energy levels in sub-nano seconds [44]. Short carrier lifetime was confirmed by Berkovskii et al., too, by CL measurement at 80 K [42]. They took the Burstein effect into account and estimated the carrier lifetime as  $(4-6)\times10^{-10}$  sec from the photo-generated electron density of ~1.5×10<sup>18</sup> cm<sup>-3</sup> and the injected current density of (1- $3)\times10^{27}$  cm<sup>-3</sup> sec<sup>-1</sup>. Such a fast decay is not favorable to solar cells, while it becomes an advantage for the application to photodetectors, which require rapid response to the on/off of light.

#### 1.4.2. Native defects

Kumagai et al. studied in detail the point defects in ZnSnP<sub>2</sub> by ab-initio calculation [45]. They considered 11 types of native point defects; Zn, Sn, and P vacancies ( $V_X$ , X = Zn, Sn, and P), Zn, Sn, and P interstitials at the ic and ia sites ( $X_{ia}$  and  $X_{ic}$ , X = Zn, Sn, and P) and Zn-on-Sn and Sn-on-Zn cation antisites ( $Zn_{Sn}$  and  $Sn_{Zn}$ ) with different charge states; and calculated their formation energies and thermodynamical transition levels (TTLs) which corresponds to defect levels detected by transient capacitance measurements. Figure 1-7 shows the TTLs of the 11 defects. TTLs of  $V_{Sn}$ ,  $V_P$ ,  $Zn_{ic}$ ,  $Zn_{ia}$ ,  $P_{ic}$ ,  $P_{ia}$ , and  $Sn_{Zn}$  are located between the valence band maximum (VBM) and the conduction band minimum (CBM), indicating these defects can work as traps or recombination centers. It was also



Figure 1-7. (a) Thermodynamical transition levels (TTLs) and formation energies of native point defects in ZnSnP<sub>2</sub> under (b) Zn-rich and (c) Zn-poor conditions calculated by Kumagai et al. [59]

reported that antisites  $Zn_{Sn}$  and  $Sn_{Zn}$  have especially low formation energies. This associates with the fact that  $ZnSnP_2$  exhibits order-disorder transition. Note that Kumagai mentioned the TTL of  $Zn_{Sn}$  is just above the VBM, and  $Zn_{Sn}$  works as an acceptor. This indicates these cation antisites would influence electrical properties. On the other hand,  $V_P$ ,  $Zn_{ic}$ , and  $Zn_{ia}$  have low formation energies and in-gap TTLs, which can cause degradation of carrier transport properties of  $ZnSnP_2$ .

On the other hand, Nakatani et al. considered antisites of Sn on Zn sites  $(Sn_{Zn})$  and the vacancy of Zn  $(V_{Zn})$  as candidates of donor and acceptor for the DAP transition, respectively, supposing that the formation energy of  $V_{Zn}$  is low as for ZnGeP<sub>2</sub> [46]. Miyauchi et al. found that annealing ZnSnP<sub>2</sub> in Zn atmosphere resulted in the decrease in the PL intensity associated with the DAP. They concluded from this finding that the decrease of  $V_{Zn}$  led to the decrease of RR from DAP transition. However, the formation energy of  $V_{Zn}$  is not low, according to the ab-initio study by Kumagai et al. [45]. As mentioned above, Kumagai et al. suggested that antisites of Zn on Sn sites (Zn<sub>Sn</sub>) have low formation energy and rather contribute to the shallow acceptor level. Nakatsuka and Nose reported annealing ZnSnP<sub>2</sub> above 500 °C in evacuated ampule resulted in the increase of the degree of order and the bandgap of ZnSnP<sub>2</sub> [47]. The decrease of RR from DAP transition confirmed by Miyauchi may be due to the decrease of Zn<sub>Sn</sub> just by annealing, and V<sub>Zn</sub> and Zn atmosphere were rather irrelevant.

#### 1.4.3. Crystal growth

Crystals of ZnSnP<sub>2</sub> are usually obtained by cooling a solution of Zn and P in Sn flux. Figure 1-8 and Figure 1-9 show the ternary phase diagram of the Zn-Sn-P system at 600 °C and the pseudobinary phase diagram of Sn-ZnP<sub>2</sub> reported by Nose and Uda [48]. We can see the two-phase region of  $ZnSnP_2$  and liquid, which is one of the reasons why we can obtain  $ZnSnP_2$  from a liquid solution. However, due to the presence of a two-phase region of liquid and ZnP<sub>2</sub>, the initial concentration of Sn in the solution must exceed 90 mol% in order to obtain pure ZnSnP<sub>2</sub> directly from the solution. This leads to an inevitably small volume fraction of obtained ZnSnP<sub>2</sub>. In addition, in such a dilute solution, crystal growth is strongly limited by the diffusion velocity of solute species. These restrictions, for example, resulted in the small dimensions of  $3 \times 4 \times 0.4$  mm<sup>3</sup> for platelet ZnSnP<sub>2</sub> prepared by simply cooling the solution with a rate of 5 °C h<sup>-1</sup> or more [49]. Therefore, the growth of bulk crystals of pure ZnSnP2 requires unidirectionally cooling the solution of 90mol%-Sn at a much slow cooling rate. In this point of view, Nakatsuka et al. used a so-called Bridgman method. They fabricated a moving furnace having a steep temperature gradient and made it possible to obtain centimeter-scale bulk crystals of pure  $ZnSnP_2$  by unidirectionally cooling from the bottom of the solution of 92 mol%-Sn in ampule with a diameter of 11 mm at a rate of 0.7 °C h<sup>-1</sup> from 700 °C in nearly 30days [40]. Such a centimeter-scale crystal is useful for various characterizations and applications, for example, absorber in solar cells. Another merit of this method is the disuse of acid, which is needed to remove the matrix of Sn when the pieces of small platelet ZnSnP<sub>2</sub> disperse throughout the matrix. Nakatsuka et al. sequentially studied the influence of cooling rate on the crystal structure and physical properties of ZnSnP<sub>2</sub> by using the same method as mentioned in the following sub-section.



Figure 1-8. Ternary phase diagram of Zn-Sn-P system at 600 °C [48].



Figure 1-9. Pseudo-binary phase diagram of Sn-ZnP<sub>2</sub> [48].

#### 1.4.4. Order-disorder phenomena

The phase transition between sphalerite and chalcopyrite ZnSnP<sub>2</sub> corresponds to the change in the randomness of atomic arrangement on the cation sublattice, as is the case for other II-IV-V<sub>2</sub> compounds [31,32]. For the chalcopyrite phase of ZnSnP<sub>2</sub>, a degree of order can be defined for the randomness. As mentioned above, the degree of order affects the physical properties of ZnSnP<sub>2</sub>. Vaipolin et al. pointed out that the change of the cooling rate during crystallization makes it possible to obtain ZnSnP<sub>2</sub> with various degrees of order and to change its physical properties [35]. Scanlon and Walsh calculated the electronic structure of ZnSnP<sub>2</sub> and predicted that the bandgap of ZnSnP<sub>2</sub> changes from 0.75 to 1.70 eV between the perfectly disordered to perfectly ordered states [50]. Nakatsuka an Nose reported a comprehensive study on the bandgap change in ZnSnP<sub>2</sub> by experimentally evaluating the degree of order [47]. They evaluated the abdgap and the long-range order (LRO) parameter  $\eta$  for ZnSnP<sub>2</sub> grown with different cooling rates using the Warren's method. According to Warren, LRO parameter  $\eta$  is expressed by the following equation:

$$\eta = r_{\alpha}^{\mathrm{Zn}} + r_{\beta}^{\mathrm{Sn}} - 1 \tag{1-5}$$

where  $r_{\alpha}^{\text{Zn}}$  and  $r_{\beta}^{\text{Sn}}$  are ratios of  $\alpha$  and  $\beta$  sites occupied by Zn and Sn atoms, respectively.  $\alpha$  and  $\beta$ 



Figure 1-10. The relationship between the bandgap and the LRO parameter of ZnSnP<sub>2</sub> grown with different cooling rates [47].

sites are respectively occupied by only Zn and Sn atoms in the perfectly-ordered state.  $\eta = 1$  corresponds to the perfectly ordered state and  $\eta = 0$  to the perfectly disordered one. The LRO is directly related to the structure factor of the superlattice reflection in x-ray diffraction (XRD) experiments. The intensity of superlattice reflection is smaller for the lower LRO parameter. Nakatsuka and Nose evaluated the LRO parameter by two methods: one is calculating the occupancy from the Rietveld refinement, and the other is comparing the measured and calculated peak area ratio of superlattice to fundamental reflections. In their report, both methods gave almost the same LRO parameters. Figure 1-10 shows the reported relationship between the LRO parameter and the bandgap for the ZnSnP<sub>2</sub> grown from the Sn solution with different cooling rates. It is obvious that the bandgap is changed from 1.35 to 1.6 eV as the increase of the degree of order.

The coordination environment around P atoms is also changed with the degree of order. In the perfectly ordered stoichiometric ZnSnP<sub>2</sub>, phosphorus atoms are surrounded by two Zn and two Sn atoms as shown in Figure 1-11 because this coordination is the electrically most stable. Following the cation-disordering, however, the number of the first nearest neighbor (1st NN) cations around P atoms can be changed partially from the most stable combination. For example, as shown in Figure 1-11, some P atoms are surrounded by 1 Zn and 3 Sn atoms under low LRO. According to Ryan et al. [36], this change of the number of 1st NN cations around P atoms resulted in small satellite peaks of <sup>31</sup>P NMR. In contrast, the coordination around Zn and Sn is rarely changed: each cation is always surrounded by 4 P atoms.



Figure 1-11. The schematic illustrations five types of the coordination around P atoms. The center one is the electrically most stable coordination: 2 Zn and 2 Sn surround each P atom.

Raman spectroscopy was also used for the evaluation of the degree of order in thin-film ZnSnP<sub>2</sub>. According to Kaminow et al. [51], the representation of the zone-center optical phonons is given by

$$\Gamma_{\text{optic}} = 1\Gamma_1 + 2\Gamma_2 + 3\Gamma_3 + 3\Gamma_4 + 6\Gamma_5 \tag{1-1}$$

and that of the acoustic modes by

$$\Gamma_{\text{acoustic}} = 1\Gamma_4 + 1\Gamma_5. \tag{1-2}$$

The five vibration modes from  $\Gamma_1$  to  $\Gamma_5$  of II-IV-V<sub>2</sub> materials with chalcopyrite structure have 17 normal-mode displacement coordinates, denoted  $v_i$ . Each  $v_i$  is associated with the atomic displacements of Zn, Sn, and P in the directions along the crystal axes, *x*, *y*, and *z*. Among the five modes,  $\Gamma_1$ ,  $\Gamma_3$ ,  $\Gamma_4$ , and  $\Gamma_5$  are Raman-active while  $\Gamma_2$  is Raman-inactive.  $\Gamma_2$  is also a disorder-activated mode. Optical modes having  $\Gamma_1$  and  $\Gamma_2$  symmetry involve only the displacements of P atoms while those with  $\Gamma_3$ ,  $\Gamma_4$ , and  $\Gamma_5$  symmetry include the displacements of Zn and Sn as well. Because  $\Gamma_1$  is associated only with the displacements of P atoms, of which coordination is more easily changed than those of cations, Actually, Mintairov et al. observed that the peak intensity of the  $\Gamma_1$  mode is decreased with the decrease of the degree of order in thin-film ZnSnP<sub>2</sub> epitaxially grown on GaAs substrates by molecular beam epitaxy (MBE) [52]. Table 1-3 summarizes the vibration frequencies measured by infra-red (IR) absorption and Raman spectroscopy and calculated in the previous studies [52–58].

Table 1-3. Vibration frequencies measured by IR absorption and Raman spectroscopy and calculated in the previous studies. \*Mulliken's irreducible representation; \*\*representation used by Kaminow et al [39].

	*	**	IR	IR	Raman	Cal.	Cal.	Cal.	Cal.	Cal.	Cal.
_			[42]	[38]	[38]	[38]	[41]	[54]	[55]	[56]	[51]
	Е	$\Gamma_{5L/T}$	—	—	—	115/115	125/125	85	77/77	77	81
	$B_1$	$\Gamma_3$	_	_	_	124	138	106	106	_	96
	$B_2$	$\Gamma_{4L/T}$	—	—	—	140/139	149/148	98	105/101	_	92
	Е	$\Gamma_{5L/T}$	—	—	—	154/153	165/164	108	119/116	_	109
	Е	$\Gamma_{5L/T}$	—	—	—	190/189	188/187	157	115/179	—	160
	$B_1$	Гз	—	—	—	208	214	191	205	—	187
	$A_2$	$\Gamma_2$	—	—	295	292	—	—	308	—	271
	$A_1$	$\Gamma_1$	—	—	309	307	304	309	298	297	286
	Е	$\Gamma_{5L/T}$	—	318/313	—/317	317/315	312/311	318	325/321	232	272
	$A_2$	$\Gamma_2$	—	—	333	331	—	—	332	—	323
	Е	$\Gamma_{5L/T}$	—/330	339/328	—/328	334/333	239/328	321	331/327	298	301
	$B_2$	$\Gamma_{4L/T}$	—	—	347/—	329/324	345/335	331	353/323	316	305
	$B_1$	$\Gamma_3$	—	—	353	352	346	333	358	297	326
	Е	$\Gamma_{5L/T}$	—	360/342	—/342	378/350	374/345	337	354/331	—	324
_	<b>B</b> <sub>2</sub>	$\Gamma_{4L/T}$	368/—	—	365/-	372/348	375/354	350	360/359	353	347

Table 1-4. Growth methods of thin-film ZnSnP <sub>2</sub> and evaluation methods of its bandgap an	d
crystal structure.	

ci ystai sti uttui t.			
Growth method	Bandgap / eV	Crystal structure	Ref.
(Abbreviation; P-source)	(Evaluation method)	(Evaluation method)	
Chemical vapor deposition	1.5 eV	Chalcopyrite?	[47]
(CVD; Ca <sub>3</sub> P <sub>2</sub> )	(absorption)	(XRD)	
Liquid phase epitaxy (LPE; SnP3)	-	Chalcopyrite (Laue back scattering)	[46]
Co-evaporation	1.62 eV	Chalcopyrite	[48, 50, 51]
(MBE; red phosphorus)	(transmittance)	(θ-2θ XRD)	
Molecular beam epitaxy	1.381 and 1.683 eV	Chalcopyrite	[38, 49,
(MBE; PH3)	(electroreflectance)	(4-axes XRD)	52–54]
Phosphidation	1.3 eV	Sphalerite	[58]
(-; Sn <sub>4</sub> P <sub>3</sub> /Sn)	(room-temperature photoluminescence)	(θ-2θ XRD)	
e-beam evaporation	1.5–1.6 eV	Sphalerite	[55–57]
(-; ZnSnP <sub>2</sub> )	(low-temperature photoluminescence)	(ω-2θ XRD)	

#### 1.4.5. Growth and physical properties of thin-film ZnSnP<sub>2</sub>

Table 1-4 summarizes growth methods and optical properties of thin-film ZnSnP<sub>2</sub>. Davis and Wolfe fabricated ZnSnP<sub>2</sub> thin films by liquid phase epitaxy (LPE), where ZnSnP<sub>2</sub> is precipitated on GaAs substrate from Sn flux by compositional supercooling as is the case of bulk crystal growth [59]. They evaluated the crystal structure of thin films grown by LPE by back-reflection Laue patterns and reported both chalcopyrite and sphalerite types could be obtained with different cooling rates, yet neither optical nor electrical properties were reported. Chemical vapor deposition (CVD) was employed by Sansregret, where ZnSnP<sub>2</sub> thin films were grown by annealing SnO<sub>2</sub> thin films in an ambient containing PH<sub>3</sub>, H<sub>2</sub>, and Zn-metal vapor [60]. The optical absorption data of the CVD film indicated the absorption edge of  $\sim 1.5$  eV, while the presence of superlattice reflection was not clearly mentioned [60]. Ajmera, Shin, and Zamanian reported that the ZnSnP<sub>2</sub> films were obtained by coevaporation of metal Zn, metal Sn, and red phosphorus. For the films obtained, the optical absorption edge of ~1.5 eV and p-type conductivity with resistivity, carrier concentration, and mobility are ~5  $\Omega$ cm, 3.37×10<sup>16</sup> cm<sup>-3</sup>, ~40 cm<sup>2</sup>V<sup>-1</sup>s<sup>-1</sup>, respectively [61–63]. Studies on the crystal structure of thin-film ZnSnP<sub>2</sub> were sequentially reported by research groups at A.F. Ioffe institute and Texas University in 1999 and 2000. They used 4-axes XRD and Raman spectroscopy for ZnSnP<sub>2</sub> thin-film grown on GaAs substrate by MBE using PH<sub>3</sub> gas source [52,64–66]. They also controlled the degree of order of ZnSnP<sub>2</sub> films by changing Sn/Zn flux ratio. One of those groups later reported that the bandgap was also changed from about 1.3–1.7 eV by the flux ratio [67]. Mukherjee et al. reported thin-film growth by e-beam evaporation and fabrication of photo-detectors [68–70]. They pointed out the incredibly fast rise and decay time of response in ZnSnP<sub>2</sub> photo-detector were correlated with defect levels within energy gaps. Nakatsuka et al. fabricated thin-film ZnSnP2 by phosphidation of Zn-Sn metal precursors using  $Sn_4P_3/Sn$  composites as a source of  $P_4$  gas [71]. The phosphidation resulted in the formation of numerous protrusions that causes short-circuit in solar cells, leading to low efficiency of less than

0.1% as shown in Table 1- [44]. Based on a chemical potential diagram of the Zn-Sn-P ternary system, Nakatsuka et al. pointed out that the formation of  $Zn_3P_2$  at first should be suppressed to avoid protrusions. To the best of our knowledge, there are no other reports on thin-film solar cells of ZnSnP<sub>2</sub>.

#### 1.4.6. Application to solar cells and related issues

In 2017, Nakatsuka et al. utilized ZnSnP<sub>2</sub> bulk crystals and reported the application of ZnSnP<sub>2</sub> to solar cells for the first time, although PCE was less than 1% [44]. Nakatsuka and his group have continuously improved the PCE of ZnSnP<sub>2</sub> solar cells up to 3.44% by modifying the fabrication procedure and device structure from the prototype, which was simply analogous to CIS-based solar cells. Table 1-5 summarizes efficiencies and the stacking structures of ZnSnP<sub>2</sub> solar cells. As is the case for other compounds, ZnSnP<sub>2</sub> solar cells also consist of surface electrode, transparent conductive layer, *n*-type buffer, *p*-type absorber, and back contact in this manner. Figure 1-12 shows a schematic illustration and *J*-*V* characteristics of the newest solar cell with a structure of Al/Al:ZnO/(Cd,Zn)S/ZnSnP<sub>2</sub>/Cu where Cu was used as back contact [72]. However, there is still much room for improvement compared with CIS- or CdTe-based solar cells.



Figure 1-12. (a) Schematic illustration and (b) *J-V* characteristics under dark and illuminated conditions of the ZnSnP<sub>2</sub> solar cell with PCE of 3.44% [43].

	Device structure	PCE / %	V <sub>OC</sub> / V	$J_{ m SC}$ / mA cm <sup>-2</sup>	FF / %	Ref.
Bulk	Al/AZO/ZnO/CdS/ ZnSnP <sub>2</sub> /Mo	0.087	0.172	1.99	25.5	[44]
	Al/AZO/ZnO/CdS/ ZnSnP <sub>2</sub> /Cu	1.97	0.452	8.2	53.3	[73]
	Al/AZO/ZnO/(Cd,Zn)S/ ZnSnP <sub>2</sub> /Cu	3.44	0.472	12.3	59.4	[72]
Thin film	Al/AZO/ZnO/CdS/ ZnSnP <sub>2</sub> /Mo	0.0027	0.0037	2.63	27.2	[74]

Table 1-5. Device parameters of ZnSnP<sub>2</sub>-based solar cells.

As well as the physical properties of absorbers, the properties of interfaces are also important for the device performance solar cells. If there are band offsets and lattice mismatches at the interfaces between different functional layers in semiconductor devices, the carrier-recombination rate becomes high resulting in loss of current and voltage. A theoretical study by Minemoto et al. [46] pointed out that small offset at pn junctions leads to high PCE,  $V_{OC}$ ,  $J_{SC}$ , and FF. From this point of view, the bandalignment between several sulfides and ZnSnP<sub>2</sub> was investigated. First-principles study by Hinuma et al. predicted that the valence band (VB) offset was ~1.0 eV for CdS/ZnSnP<sub>2</sub> and ~1.0 eV for ZnS/ZnSnP<sub>2</sub>, which is not so different than those for CdS/ or ZnS/CuInSe<sub>2</sub> [75]. In contrast, x-ray photoelectron spectroscopy (XPS) study by Nakatsuka et al. revealed that the VB offset is nearly 2.0 eV for CdS/ZnSnP<sub>2</sub>, which could result in a significant loss of voltage. By using (Cd,Zn)S, a solid solution of CdS and ZnS, Akari et al. improve the conversion efficiency up to 3.44% [72]. However, there should still be much loss in the open-circuit voltage. CdSnP<sub>2</sub> is one of the most promising n-type buffer materials for ZnSnP<sub>2</sub> junction exhibited favorable diode characteristics, although the series resistance was relatively high [76].

On the other hand, back contacts are selected in the viewpoint of the offset between the VBM of absorbers and the work function of subjected metals. For ZnSnP<sub>2</sub> with the VBM of 5.2 eV, Al (4.28 eV), Ag (4.26 eV), Mo (4.6 eV), and Cu (4.65 eV) were examined by Nakatsuka et al. [73,77], where

the VBM corresponds to the ionization potential. Although every metal exhibited high contact resistance and rectification behavior like Schottky diode as-deposited, only Cu showed a reduction of the resistance by annealing. Figure 1-13 and Figure 1-14 show cross-sectional images by scanning transmission electron microscopy (STEM) and resistance-current (*R-I*) characteristics of the junction of Cu/ and Mo/ZnSnP<sub>2</sub>, respectively, before and after annealing. In contrast to Mo/ZnSnP<sub>2</sub>, where any change could not be confirmed in the microstructure and *R-V* characteristics, some reaction and reduction of resistance are confirmed at Cu/ZnSnP<sub>2</sub> interfaces. This implies not only work functions but also reactivity can be criteria for building up the low resistive junction. However, details of the reduction mechanism are unrevealed and the series resistance of the device with PCE of 3.44% was 15  $\Omega$  cm<sup>2</sup> [72], which is almost ten times larger than that calculated from the thickness (~200 µm) and the resistivity (10–70  $\Omega$  cm) of ZnSnP<sub>2</sub> bulk crystals [40].



Figure 1-13. Cross-sectional STEM images of (a) before and (b) after annealing at 300 °C for 60 min and (c) R-I characteristics of Cu/ZnSnP<sub>2</sub> junction.



Figure 1-14. Cross-sectional STEM images of (a) before and (b) after annealing at 300 °C for 60 min and (c) R-I characteristics of Mo/ZnSnP<sub>2</sub> junction.

# **1.5.** Objective and outline of this study

As described in the previous sections, high series-resistance in devices, small carrier lifetime, and establishment of thin-film preparation are challenging issues to overcome for further improving the performance of ZnSnP<sub>2</sub> solar cells. Thus, the objective of this study was set as follows.

1. Reduction of the series resistance: Upon to the report by Nakatsuka et al., the series resistance of the device with PCE of 3.44% is about  $15 \Omega \text{ cm}^2$ , which is almost ten times larger than that calculated from the resistivity and thickness of ZnSnP<sub>2</sub> bulk crystals used as absorbers. In addition, the roll-over behavior of the *J-V* curve of the device indicates the existence of a potential barrier at the interface between ZnSnP<sub>2</sub> absorbers and Cu back contact. Considering the difference of resistance between the Cu/ZnSnP<sub>2</sub> and Mo/ZnSnP<sub>2</sub> interfaces after annealing, the reactive diffusion is a key for the reduction of resistance. In Chapter 2, the Cu/ZnSnP<sub>2</sub> interfaces are re-investigated in detail and discuss the mechanism of the reduction of resistance.

2. Identification of the origin of small carrier lifetime: Studies of recombination behavior using CL by Berkovskii et al. and PL by Nakatsuka et al. indicate a short minority carrier lifetime of about sub-nano seconds. It becomes a significant problem in device performance. In Chapter 3, the Recombination behavior of carriers is investigated through the characterization of bulk crystals by DLTS and PL. In addition, experimental results are discussed based on defect properties calculated by Kumagai et al. to present the *compass* for device design.

3. Raman spectroscopy on ZnSnP<sub>2</sub> with various degrees of order: As mentioned above, the degree of order has a significant influence on the physical properties of ZnSnP<sub>2</sub>. The degree of order of powder ZnSnP<sub>2</sub> was evaluated by standard XRD measurement as Nakatsuka and Nose demonstrated. However, XRD is less effective for anisotropic specimens like thin films due to orientation problems. In Chapter 4, we discussed non-polarized Raman spectra of bulk ZnSnP<sub>2</sub> with various degrees of order and discussed its possibility for the use of evaluating the degree of order of thin films.

4. Thin-film growth by MBE: The formation of  $Zn_3P_2$  and protrusions in the phosphidation process suppress the PCE less than 0.1% for the thin-film solar cells of  $ZnSnP_2$ . Co-evaporation processes like MBE can be a solution for directly obtaining thin-film  $ZnSnP_2$  without protrusions. In Chapter 5, we discuss the influence of growth temperature on the physical properties of thin-film ZnSnP<sub>2</sub>.

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# 2. Cu<sub>3</sub>P back buffer layer for ZnSnP<sub>2</sub> solar cells

## 2.1. Introduction

Solar cells based on compound semiconductors such as chalcogenides and pnictides are one of the promising alternatives to silicon solar cells. Among various compounds, GaAs, CdTe and Cu(In,Ga)Se<sub>2</sub> (CIGS) have been well investigated and the conversion efficiencies of these compoundsbased solar cells are over 20% [1–3]. On the other hand, the use of minor or toxic elements such as Ga, As, In, Cd, Te, and Se may disturb the further spread of solar cells. The alternative materials have been thus investigated intensely such as  $Cu_2ZnSnS_{4-x}Se_x$  (CZTSSe) [4], Se [5],  $Cu_2SnS_3$  [6],  $CuSbSe_2$  [7],  $Cu_2O$  [8], SnS [9], FeS<sub>2</sub> [10], Sb<sub>2</sub>Se<sub>3</sub> [11], Zn<sub>3</sub>P<sub>2</sub> [12], and ZnSnN<sub>2</sub> [13]. As summarized in Table 2-1, however, the conversion efficiencies are still below 10 % except for CZTSSe.

	Efficiency	Voc	$J_{ m SC}$	FF	
Absorber					Year
	/ %	/ V	$/ \text{ mA cm}^{-2}$	/ %	
Se	6.5	0.969	10.6	63.4	2017
Sb <sub>2</sub> Se <sub>3</sub>	9.2	0.400	32.6	70.3	2018
Cu <sub>2</sub> O	8.1	1.10	11.5	60	2016
SnS [2]	4.8	0.33	24.7	58.5	2019
$Cu_2SnS_3$	4.3	0.258	35.6	46.7	2019
CuSbSe <sub>2</sub>	4.7	0.336	26.3	53.0	2017
Cu <sub>2</sub> ZnSn(S,Se) <sub>4</sub>	12.6	0.513	35.2	69.8	2013
Zn <sub>3</sub> P <sub>2</sub> [3]	4.5	0.41	21.4	51	2010
ZnSnN <sub>2</sub>	1.5	0.360	7.5	57	2018
ZnSnP <sub>2</sub>	3.87	0.535	12.1	59.8	2019

Table 2-1. Efficiency and parameters for various solar cells are summarized based on the paper by Wong et al. [1], except for SnS [2] and Zn<sub>3</sub>P<sub>2</sub> [3].

ZnSnP<sub>2</sub> (ZTP) has recently attracted much attention because of the earth-abundant constituents, the high absorption coefficient close to those of CdTe and GaAs in the visible region [15], and the bandgap controllable in 1.3–1.7 eV [16, 17]. The chalcogenide compounds are the mainstream in studies on compound solar cells, while pnictides including ZTP, Zn<sub>3</sub>P<sub>2</sub>, and ZnSnN<sub>2</sub> belong to a novel absorber family. Our group reported the preparation of ZTP thin films by phosphidation of Zn-Sn precursors; however, it was difficult to apply to devices due to the surface roughness [18]. Therefore, bulk crystals of ZTP obtained by a conventional solution growth using Sn flux were used for solar cells [19, 20]. The grain size is about 1 mm and the smooth surface can be prepared by mechanical polishing and chemical etching. In the last few years, solar cells using ZTP bulk crystals have been developed in our group and the highest conversion efficiency is 3.44 % for the cell structure with Al/Al:ZnO/ZnO/(Cd,Zn)S/ZTP/Cu [21]. Nakatsuka et al. applied Cu to back electrodes of ZTP solar cells for the first time and suggested that it is one of the key factors for the reduction of series resistance [22]. However, the way to optimize and the mechanism is still unclear.

In this work, we thus investigated the relationship between the structure and carrier transport properties at the Cu/ZTP interface and applied the knowledge to ZTP solar cells. In particular, we focused on the reactive diffusion and the formation of intermediate compounds, Cu3P, at the Cu/ZTP interface through heat treatment under various conditions. We already reported the preliminary results on Cu electrode characteristics and reactive diffusion [23]. In this paper, the detailed structure around the interface, the mechanism of resistance reduction and the device demonstration are discussed.

## 2.2. Investigation on Cu/ZnSnP<sub>2</sub> interface

#### 2.2.1. Experimental procedures

ZTP bulk crystals were prepared according to our previous report [19]. Starting materials, zinc shots (99.9999 %, Kojundo Chemical Laboratory), tin shots (99.999 %, Kojundo Chemical Laboratory),

and red phosphorus flakes (99.9999 %, Kojundo Chemical Laboratory) were sealed in evacuated quartz ampules with an inner diameter of 11 mm under a pressure of  $10^{-2}$  Pa. The overall weight of the materials was about 60 g, and the nominal molar composition was 92 mol%Sn, 2.7 mol%Zn, and 5.3 mol%P. The ampules were then heated up to 700 °C and kept for 12 hours for homogenization. After homogenization, the ampules were unidirectionally cooled from the bottom with a rate of 12 °C day<sup>-1</sup>. The obtained ingots were cut into wafers with a thickness of about 1 mm using a diamond wheel saw.

Cu electrodes were deposited on the etched surface of ZTP wafers by DC sputtering using Cu target (Furuuchi Chemical). Before the deposition, the surface of the wafers was polished with a series of emery papers and finally with 1  $\mu$ m diamond slurry on a buff sheet, and then etched in 1/2 diluted aqua regia for 5 min to remove a damaged layer by mechanical polishing. Subsequently, the wafers were ultrasonic-cleaned by sequential 1/4 diluted hydrochloric acid and ultrapure water. Shadow masks with two circle windows were used for the deposition of two electrodes on the surface. The diameter of the windows and their distance were both 1.5 mm. The power density, the working pressure of Ar gas, and the duration during sputtering were 4 W cm<sup>-2</sup>, 0.8 Pa, and 120 min, respectively, so that the thickness of electrodes was about 500 nm. For Cu/Cu<sub>3</sub>P/ZTP specimens, Cu<sub>3</sub>P was deposited on ZTP wafers by DC sputtering through the shadow mask prior to Cu deposition. A sputtering target of Cu<sub>3</sub>P with a diameter of 1 inch was prepared by cutting out from a Cu-P ingot (15 wt%P, Osaka Alloy Works Co. Ltd.). During sputtering, the power density, the working pressure, and the duration were set at 6 W cm<sup>-2</sup>, 3.0 Pa, and 5 min, respectively, to control the thickness of Cu<sub>3</sub>P to 20 nm. The deposition of Cu on Cu<sub>3</sub>P was also carried out by the same conditions as described above. Some of Cu/ZTP and Cu/Cu<sub>3</sub>P/ZTP specimens were annealed at 400 °C for 5-60 min in evacuated quartz ampules under a pressure of  $10^{-2}$  Pa. The ampules were quenched into water after annealing.

The current-voltage (I-V) characteristics of Cu/ZTP and Cu/Cu<sub>3</sub>P/ZTP specimens before and

after annealing were evaluated by a source meter (2400, Keithley). The cross-sectional microstructure of Cu/ZTP and Cu/Cu<sub>3</sub>P/ZTP interfaces were investigated by scanning transmission electron microscopy (STEM, JEM-2100F, JEOL) equipped with energy-dispersive X-ray spectroscopy (EDS, JED2300T, JEOL). Selected area electron diffraction (SAED) patterns were also obtained by the same equipment. Specimens for STEM observations were prepared by focused ion beam (FIB, JFIB2300, JEOL) with Ga<sup>+</sup> ion beam accelerated at 5.5 keV. The surface morphology of specimens was observed by scanning electron microscopy (SEM, JCM-6000Plus, JEOL), and the corresponding elemental distribution was analyzed by EDS (JED-2300 Series, JEOL). The work function and the ionization potential were evaluated by a photoelectron yield spectroscopy system (PYS, BIP-KV201, Bunkoukeiki). The performance of ZTP solar cells was evaluated under air-mass 1.5 global (AM 1.5G) illumination with 100 mW cm<sup>-2</sup> using a system with a solar simulator (OTENTO-SUN II, Bunkoukeiki) together with the dark condition. The external quantum efficiency (EQE) spectra were obtained by a measurement system (SM-250, Bunkoukeiki). The relationship between capacitance and a bias voltage of the cells was examined in the dark conditions at room temperature by Probe Station (PS-100, Lake Shore Cryotronics) and LCR meter (E4980A, Agilent). The repetition rate and amplitude were 10 kHz and 10 mV, respectively.

#### 2.2.2. Microstructure around interface and carrier transport behavior

Figure 2-1 shows the cross-sectional STEM-dark field (DF) images and the corresponding EDS mappings of Cu, Zn, Sn, and P for Cu/ZTP specimens before and after annealing at 400 °C. The white region shows Cu film in the DF image of Fig. 2-1(a), while ZTP is at the bottom side. The dark area was observed between Cu and ZTP, which might be sputtered during the FIB process for the preparation of specimens. In the case before annealing, it is speculated that chemical bonding at the interface was not strong, and then some atoms were sputtered during the FIB process. Hence, we

considered that no interdiffusion occurred before the FIB process. As shown in Figs. 2-1(b) and (c), structural changes are recognized around the interface after annealing, where diffusion of Zn and Sn from ZTP to Cu side is observed. The formation of an intermetallic compound, Cu<sub>3</sub>Sn, was suggested by EDS composition analyses in the area such as white particles and top layer in Fig. 2-1(c), where Sn and Cu were both detected. On the other hand, both Cu and P were detected in the white-grey regions in the DF images after annealing. The composition analysis and SAED patterns indicated the formation of Cu<sub>3</sub>P as described below. Figures 2-2(a) and (b) show SAED patterns obtained from the white-grey and ZTP regions. The former pattern is well assigned to [1100] zone axis of Cu<sub>3</sub>P [24], which coincides with the results of the composition analysis. In our previous paper [22], such reaction products were not observed, and the interdiffusion of Cu, Sn, and P might be at an early stage of the formation of Cu<sub>3</sub>P and Cu<sub>3</sub>Sn.

The discussion on the structure around Cu<sub>3</sub>P/ZTP interface can also be derived from SAED patterns. The SAED pattern taken on the ZTP region shown in Fig. 2-2(b) is well-indexed to the [110] zone axis of ZTP. Arrays of the diffraction spots highlighted by orange boxes in Figs. 2-2(a) and (b) are systematic reflections of 0001 for Cu<sub>3</sub>P and 112 for ZTP, respectively, and they are parallel to each other. This means that (0001) plane of Cu<sub>3</sub>P is parallel to (112) plane of ZTP, and hence there is an epitaxial relationship of Cu<sub>3</sub>P [1100](0001) // ZTP [110](112) because these patterns were obtained with the incident electron beam with the same direction. In fact, the area of Cu<sub>3</sub>P shown by white-grey in the STEM-DF images is certainly beside ZTP regions. We further discuss the orientation relationship between Cu<sub>3</sub>P and ZTP from the viewpoint of lattice matching. Figures 2-2(c) and (d) show atomic arrangements of Cu<sub>3</sub>P (0001) and ZTP (112) planes, respectively. Although Cu, Zn, and Sn atoms are on slightly-displaced planes from the phosphorus sublattice plane, they are displayed in the figures for easy understanding. The arrangements of phosphorus atoms in both planes are almost the same, and the distances between the first nearest neighbor phosphorus atoms are 4.02 Å for Cu<sub>3</sub>P

[24] and 4.00 Å for ZTP [25], calculated from lattice constants. The lattice mismatch calculated from phosphorus sublattice is thus less than 0.5%, and a lattice-matched epitaxial interface between Cu<sub>3</sub>P and ZTP can be understood.

Figures 2-3(a) and (b) show I-V characteristics of Cu/ZTP specimens before and after annealing at 400 °C. Each curve is labeled from A to D corresponding to the specimens with each annealing period: 5, 15, 30, and 60 min, respectively. It is noticed that I-V curves before annealing seem slightly different, although they should be originally consistent with each other because of the same preparation procedure. There are some variations among specimens; however, it is not a matter since the effects of annealing on *I-V* curves are discussed in this study. The nonlinear relationship is confirmed in *I-V* curves before annealing shown in Fig. 2-3(a), and an effect of a potential barrier is considered at the Cu/ZTP interface. It is understood that the annealing enhanced the current by one order in every specimen paying attention to the vertical axes in Fig. 2-3(b), and the linearity of the I-V characteristics is enhanced, which suggests that the carrier transport behavior changes from Schottky to Ohmic resulting in reducing resistance. In the specimens with annealing for 15 and 30 min, labeled B and C, the formation of Cu<sub>3</sub>P was confirmed in the cross-sectional STEM observation as described above and it affects the change of I-V characteristics. The resistances evaluated by linear regression to the *I-V* curves in the range from -0.5 to 0.5 V are shown in Fig. 2-3(c). The average value before annealing is shown by a blue dashed line. The annealing clearly makes the reduction of resistance and the lowest was obtained when annealing for 30 min. On the other hand, the resistance in the case of annealing for 60 min is higher than that for 30 min. One of the important factors is the microstructure at the surface. As shown in Fig. 2-4, the formation of  $Cu_3P$  is considered even in the specimen with annealing for 60 min since the white-grey regions are confirmed in the DF image, while areas consisting of metals at the surface are inhomogeneous. Such microstructure is also observed for the specimen with annealing for 30 min, which showed the lowest resistance. The surface morphology of each specimen was observed as shown in Fig. 2-5 and the areas without detecting metals such as Cu and Sn are outstanding with increasing annealing period. The decrease of such areas leads to the reduction of electrode areas, resulting in higher resistance. The inhomogeneity of metal areas might come from the aggregation of Cu; however, it is surprising that the surface diffusion of Cu occurs at 400 °C, a much lower temperature than the melting point, 1085 °C. The impact of Sn with the lower melting point, which diffused from ZTP, is speculated and further investigation is necessary.



Figure 2-1. Cross-sectional STEM-DF images and corresponding EDS mappings of Cu, Zn, Sn, and P for Cu/ZTP specimens (a) before and after annealing at 400 °C for (b) 15 and (c) 30 min.



Figure 2-2. SAED patterns taken from (a) Cu<sub>3</sub>P and (b) ZTP regions at the interface in Cu/ZTP specimen annealed at 400 °C for 15 min. Atom configurations of (c) Cu<sub>3</sub>P (0001) and (d) ZTP (112) planes.



Figure 2-3. *I-V* characteristics of Cu/ZTP specimens (a) before and (b) after annealing at 400 °C. Each curve is labeled from A to D corresponding to the annealing period, 5, 15, 30, and 60 min, respectively. (c) Resistance evaluated from *I-V* curves.

# a) before annealing

DF	Cu K	Zn K	Sn L	РК
			and the second second	
100 nm				

# b) 5 min

DF	Cu K	Zn K	Sn L	РК
State of the lot				
<u>1 μ</u> η	n			

c) <u>15 min</u>

DF	Cu K	Zn K	Sn L	РК
1 μm				

# d) 30 min



e) 60 m	in				
DF	Cu K	Zn K	Sn L	РК	
			Total Contraction States		
	1 <u>μ</u> m				國家的

Figure 2-4. Cross-sectional STEM-DF images and corresponding EDS mappings of Cu, Zn, Sn, and P for Cu/ZTP specimens (a) before and after annealing at 400 °C for (b) 5, (c) 15, (d) 30, and (e) 60 min.



Figure 2-5. SEM images and corresponding EDS mappings of Cu, Sn, and P on the surfaces of Cu/ZTP specimens after annealing at 400 °C for (a) 5, (b) 15, (c) 30, and (d) 60 min.

# 2.2.3. Band alignment of Cu<sub>3</sub>P and ZnSnP<sub>2</sub>

Concerning carrier transport at the interface, not only structural features but also electrical aspects of Cu<sub>3</sub>P should be discussed. The electrical properties of Cu<sub>3</sub>P films on glass substrates such as resistivity, carrier concentration, and mobility were evaluated to be  $8.12 \times 10^{-4} \Omega$  cm,  $1.43 \times 10^{23}$  cm<sup>-3</sup> and 0.205 cm<sup>2</sup> V<sup>-1</sup> s<sup>-1</sup>, respectively, through Hall effect measurements. For the measurements, Cu<sub>3</sub>P films were prepared on glass substrates by RF-sputtering. The type of majority carrier was difficult to be determined and a quite high carrier concentration suggests that the Cu<sub>3</sub>P film has metallic or a degenerated semiconducting behavior at around room temperature. In the previous works,

Robertson et al. described a single crystal of Cu<sub>3</sub>P was metallic with a resistivity of  $5 \times 10^{-5} \Omega$  cm [26], and Wolff et al. concluded that sintered  $Cu_3P$  showed a p-type conductivity with the carrier concentration of  $3 \times 10^{21}$  cm<sup>-3</sup> [27]. Figure 2-6(a) shows the results of photoelectron yield spectroscopy (PYS) measurements for ZTP and Cu<sub>3</sub>P powders. We here considered Cu<sub>3</sub>P to be metallic and evaluated the work function to be 5.2 eV, which is consistent with the report by Manna et al. [28]. They recognized Cu<sub>3</sub>P as a semiconductor and investigated that the bandgap and ionization potential of Cu<sub>3</sub>P were 1.4 eV and 5.2 eV, respectively, through scanning tunneling microscope (STM)-based *I*-V measurements. On the other hand, the ionization potential for ZTP was 5.25 eV. Consequently, the band positions for both compounds are expressed as shown in Fig. 6(b), and the ionization potential of ZTP and the work function of  $Cu_3P$  are comparable. In other words, the level of valence band maximum (VBM) of ZTP and the Fermi level of Cu<sub>3</sub>P are similar, expecting the small potential barrier against hole transport at Cu<sub>3</sub>P/ZTP interface because the Fermi level of ZTP is located near VBM as shown in Fig 2-6(c). In our previous work, the potential barrier (band offset) between ZTP and CdS was evaluated to be 2.0 eV by XPS analysis [29], while it was also reported that the offset between Cu<sub>3</sub>P and CdS was 1.9 eV by Manna et al. The band diagram shown in Fig. 2-6(b) can also be understood from these results based on CdS.



Figure 2-6. (a) PYS spectra and (b) band positions of ZTP and Cu<sub>3</sub>P. Bandgap of ZTP is referred to the previous photoluminescence study by Nakatsuka et al. [20].

# 2.3. Fabrication of ZnSnP2 solar cells with Cu<sub>3</sub>P inserted

#### 2.3.1. Experimental procedures

The cell structure was referred to our previous reports [21, 22]. The back electrode of Cu with and without Cu<sub>3</sub>P was prepared on the polished and etched surface of ZTP wafers by the same procedure described in the previous section, where the annealing conditions were 400 °C for 5 min in evacuated quartz ampules. After that, each wafer was attached to a glass substrate to easily handle in the later procedure. The electrode side was in contact with the glass substrate with a pinhole with a diameter of 1 mm for a pathway to the back electrode. The opposite surface of the ZTP wafer was mechanically polished until the wafer thickness of  $200-300 \ \mu\text{m}$ . The polished surface was etched by 1/2 diluted aqua regia for 15 min and then ultrasonic-cleaned by ultrapure water. An *n*-type buffer material, CdS was deposited by the chemical bath deposition (CBD) method. The solution was prepared using 11 mmol L<sup>-1</sup> CdSO<sub>4</sub>, 2.3 mol L<sup>-1</sup> ammonia, and 56 mmol L<sup>-1</sup> thiourea. The temperature for the deposition was 80 °C so that the typical thickness of CdS was 50 nm. The window layer ITO was deposited on CdS by RF sputtering using an ITO target prepared by sintering the mixture of In<sub>2</sub>O<sub>3</sub> (99.99%, Kojundo Chemical Laboratory) and SnO<sub>2</sub> powders (99.99%, Kojundo Chemical Laboratory). The power density, the working pressure, and the duration were 2 W cm<sup>-2</sup>, 0.55 Pa, and 120 min, respectively. The thickness and the typical resistivity of ITO film were 250 nm and  $10^{-3} \Omega$ cm. Finally, Al grid electrodes were prepared by thermal evaporation of Al wire (99.999%, The Nilaco Corporation) under the pressure of  $10^{-3}$  Pa.

#### 2.3.2. Effect of inserting Cu<sub>3</sub>P

As discussed in the previous section, the formation of  $Cu_3P$  at the interface is an advantage for carrier transport from the viewpoints of lattice and band alignments. On the other hand, the annealing to obtain low resistance led to Cu agglomeration and inhomogeneity of the electrode. It seems

originally difficult to prepare a uniform Cu<sub>3</sub>P layer with reactive diffusion between Cn and ZTP. We thus considered making Cu/Cu<sub>3</sub>P/ZTP structure by intentional deposition of Cu<sub>3</sub>P. Figure 2-7 shows I-V characteristics for Cu/Cu<sub>3</sub>P/ZTP specimens, in which Cu<sub>3</sub>P film was prepared on ZTP wafer by DC sputtering before Cu deposition. The I-V characteristics for both Cu/ZTP and Cu/Cu<sub>3</sub>P/ZTP specimens before annealing are similar, although the current in specimens with Cu<sub>3</sub>P is slightly higher. In the case of Cu/ZTP specimens discussed above, the annealing for 30 min was necessary to obtain the lowest resistance, and no significant improvement was observed by annealing only for 5 min. On the other hand, it was confirmed that the current and the linearity were expressly enhanced even after annealing for 5 min in Cu/Cu<sub>3</sub>P/ZTP specimens, and the resistances after annealing for 5 and 30 min are the same in level. The annealing for reactive diffusion might not be needed for a long period by inserting Cu<sub>3</sub>P in advance, resulting in keeping a homogeneous Cu electrode. Consequently, we investigated the cross-sectional structures around the Cu/Cu<sub>3</sub>P/ZTP interface before and after annealing for 5 min as shown in Figure 2-8. Figure 2-9 also shows the SEM images of the surface for Cu/Cu<sub>3</sub>P/ZTP specimens after annealing. A part of the impact of inserting Cu<sub>3</sub>P on Cu aggregation was already reported by our group [30]. The thickness of the  $Cu_3P$  layer and Cu electrode before annealing was about 25 nm and 500 nm, respectively, while the reacted region extended to 400-500 nm of thickness by annealing only for 5 min. The top layer with 30-40 nm consisting of metals such as Cu, Zn, and Sn was uniformly formed. The faceting was confirmed at the interface between reacted region and ZTP. The facet plane of ZTP is in contact with the Cu<sub>3</sub>P region, which is understandable considering the epitaxial relationship between them as discussed above. In the middle region, the distribution of two types of metallic phases such as Cu-Zn-Sn and Cu-Sn regions was observed in the Cu<sub>3</sub>P matrix; metallic phases and Cu<sub>3</sub>P are recognized as white and light grey regions, respectively, also in the DF image. Here, it is surprising that the complicated microstructure formed by a short annealing period, 5 min. In the case of Cu/ZTP specimens, annealing for more than 15 min was

necessary to obtain reacted region with the thickness of a few hundred micrometers. It is thus concluded that Cu<sub>3</sub>P works as rather a diffusion promotor, although it was considered to suppress the reactive diffusion. In particular, the region of Cu<sub>3</sub>P extended compared to the case before annealing, and it is speculated that ZTP reacted with Cu to form metallic phases and Cu<sub>3</sub>P.



Figure 2-7. *I-V* curves of (a) Cu/ZTP and (b) Cu/Cu<sub>3</sub>P/ZTP specimens before and after annealing at 400 °C for 5 and 30 min. Solid and dashed lines represent before and after annealing, respectively. Results before annealing are shown by dotted curves.



Figure 2-8. Cross-sectional STEM-DF images and corresponding EDS mappings of Cu, Zn, Sn, and P for Cu/Cu<sub>3</sub>P/ZTP specimens (a) as prepared and (b) after annealing at 400 °C for 5 min.



Figure 2-9. SEM images and corresponding EDS mappings of Cu, Sn, and P on the surfaces of Cu/Cu<sub>3</sub>P/ZTP specimens after annealing at 400 °C for (a) 5, (b) 15, (c) 30, and (d) 60 min.

#### 2.3.3. Demonstration on devices

Furthermore, the benefit of inserting Cu<sub>3</sub>P is applied to solar cell devices. We demonstrated solar cells with the structure of Al/ITO/CdS/ZTP/Cu<sub>3</sub>P/Cu. The annealing condition for back electrodes was 400 °C for 5 min. CdS was selected as a partner material because n-type materials with suitable conductivity other than CdS could not be prepared in this study. Although our previous work indicated that the offset of conduction band minimum (CBM) between ZTP and CdS is as large as about 1.2 eV [29], the aim of this work is the investigation of the interface between ZTP and back electrode. Figure 2-10 shows dark and illuminated *J-V* characteristics of solar cells with and without

Cu<sub>3</sub>P intentionally inserted between Cu and ZTP. The active area of the cell with Cu<sub>3</sub>P insertion was evaluated to be 12.53 mm<sup>2</sup> from the photo by image analysis and measurement software. In the case without inserting Cu<sub>3</sub>P, the *J*-V curve under illuminated shows roll-over in forward bias, resulting in that a cross-over behavior with the curve under dark condition was observed, as confirmed in our previous cells [21, 22]. Such behavior was also confirmed in CdTe/Au back contact in CdTe solar cells [31]. On the other hand, the J-V characteristics in the cells with Cu<sub>3</sub>P by sputtering are closer to an ideal diode curve, and the current density was enhanced. This is also understood from EQE spectra discussed later, where it is recognized that the carrier collection is remarkably enhanced in the whole wavelength range. This improvement comes from the reduction of a Schottky barrier at the back electrode side, and the series resistance was actually reduced to 1.5  $\Omega$  cm<sup>2</sup>. The short-circuit current density, the open-circuit voltage, and the fill factor are 12.1 mA cm<sup>-2</sup>, 0.535 V, and 0.598, respectively, and every cell parameter was improved compared to cells without Cu<sub>3</sub>P inserting. Consequently, the best conversion efficiency of 3.87 % has been achieved. The impact of inserting Cu<sub>3</sub>P also leads to good reproductivity shown in Figure 2-11, where the efficiency of every cell with the same structure was around 3%. As observed in CdTe solar cells, a back contact should be controlled to be Ohmic with low resistance for higher efficiency. Wu et al. investigated the effects of  $Cu_x$ Te back contact on device performance and demonstrated that the control of Cu<sub>x</sub>Te phases is critical for J-V curves [32]. In CIGS solar cells, it was suggested that the formation of MoSex was self-organizing with lattice-matched to CIGS during the deposition of CIGS on Mo [33], which must be a key to achieve an Ohmic contact between CIGS and Mo back electrode. In the practical devices as seen above, suitable materials contribute to back contacts, which is also considered as a *back buffer* because they play as a *connector* in between absorber and back electrode. In ZTP solar cells, Cu<sub>3</sub>P is really a *back buffer* material for the Cu back electrode.



Fig. 2-10. J-V characteristics of solar cells (a) without and (b) with inserting Cu<sub>3</sub>P.



Figure 2-11. Efficiencies, short circuit current densities ( $J_{SC}$ ), open-circuit voltages ( $V_{OC}$ ), and fill factor (*FF*) of ZTP solar cells with the structure of Al/ITO/CdS/ZTP/Cu<sub>3</sub>P/Cu fabricated in this study.

EQE spectra under various biases are also shown in Figure 2-12, where Cu<sub>3</sub>P/Cu and Al/ITO respectively correspond to positive and negative electrodes as schematically shown in Figure 2-13. The bias-dependence of EQE indicates that the carrier collection, particularly in the range of longer wavelength, is needed to be further improved in ZTP solar cells even with Cu<sub>3</sub>P inserted. Figure 2-14 shows the Mott-Schottky plot of the ZTP solar cell with the highest conversion efficiency. The built-in potential and the depletion width were evaluated by the Mott-Schottky analysis using the following equation for heterojunction [34].

$$\frac{A^2}{C^2} = \frac{2(\varepsilon_{\rm ZTP}N_a + \varepsilon_{\rm CdS}N_d)}{q\varepsilon_0\varepsilon_{\rm ZTP}\varepsilon_{\rm CdS}N_aN_d}(\phi_{bi} - V), \qquad (2-1)$$

where *C* is measured capacitance, *A* is the area of *pn*- junction corresponding to an active area of the cell in this work,  $\phi_{bi}$  is the built-in potential, and *V* is bias voltage. The built-in potential was 1.16 V obtained from the intercept of the bias voltage axis, and it is larger compared to the cell showing the efficiency of 3.44 % reported in the previous paper: 0.75 V [21]. This indicates that the potential around *pn*-junction was not adequately evaluated in the previous paper due to the Schottky-like behavior at the interface between ZTP and Cu back electrode, while the built-in potential in the present cell is nearly ideal considering the bandgap of ZTP. Here, the slope of the regression line in the Mott-Schottky plot is expressed by *b*, and then we can obtain the following expression of the net concentration of ionized acceptor defects in p-region  $N_a$ ,

$$N_a = \frac{2\varepsilon_{\rm CdS}N_d}{(bq\varepsilon_0\varepsilon_{\rm CdS}N_{\rm d} - 2)\varepsilon_{\rm ZTP}},$$
(2-2)

where q is the elementary charge and  $\varepsilon_0$  is the vacuum permittivity. The relative dielectric constant of CdS  $\varepsilon_{CdS}$  is 5.4 [34,35], and that of ZTP  $\varepsilon_{CdS}$  was obtained to be 9.52 from the results calculated by Kumagai et al. [36]. They evaluated the dielectric tensor by first-principles calculation using HSE06. Assuming that the net concentration of ionized donor defects in n-region  $N_d$  is  $1 \times 10^{18}$  cm<sup>-3</sup>,  $N_a$  is calculated to be  $3.9 \times 10^{17}$  cm<sup>-3</sup>, which is reasonable considering the hole concentration of ZTP bulk crystals of  $10^{16}$ – $10^{17}$  cm<sup>-3</sup> [19]. Furthermore, the depletion widths of p- and n-regions,  $W_p$  and  $W_n$ , around heterojunction are expressed by the following equations [34],

$$W_p = \sqrt{\frac{2N_d \varepsilon_0 \varepsilon_{\text{ZTP}} \varepsilon_{\text{CdS}} \phi_{bi}}{qN_a (\varepsilon_{\text{ZTP}} N_a + \varepsilon_{\text{CdS}} N_d)}}, \qquad (2-3)$$

$$W_n = \sqrt{\frac{2N_a \varepsilon_0 \varepsilon_{\text{ZTP}} \varepsilon_{\text{CdS}} \phi_{bi}}{qN_d (\varepsilon_{\text{ZTP}} N_a + \varepsilon_{\text{CdS}} N_d)}} \,. \tag{2-4}$$

The depletion widths of *p*- and *n*-regions were calculated to be 43 and 17 nm, respectively, using the above built-in potential and defect concentrations. This is comparable to other solar cell devices with inorganic compound absorbers.

In this work, the issue on the interface between ZTP and Cu back electrode has been solved by inserting Cu<sub>3</sub>P, and the impact of *pn*-junction with CdS on lower cell performance might not be high. Therefore, for the further improvement of cell performance, detailed re-investigation on bulk properties such as minority carrier lifetime in addition to interfaces is necessary.



Figure 2-12. (a) EQE spectra of ZTP solar cells with and without inserting Cu<sub>3</sub>P. (b) EQE spectra of the soalr cell with Cu<sub>3</sub>P insertion under various biases.



Figure 2-13. Schematic illustration of the direction of the bias applied on the ZTP-based solar cell in the EQE measurement.



Figure 2-14. Mott-Schottky plot of solar cell with Cu<sub>3</sub>P insertion. The dotted line represents linear regression to measured values.

#### 2.4. Summary of this chapter

We investigated the reactive diffusion at the interface between the Cu back electrode and ZTP absorber and found that the epitaxial formation of Cu<sub>3</sub>P on ZTP through annealing at 400 °C. The electron diffraction analyses revealed the relationship of Cu<sub>3</sub>P [1100](0001) // ZTP [110](112) and the lattice-mismatch was calculated less than 0.5 % from the phosphorus sublattice in both compounds. On the other hand, the work function of Cu<sub>3</sub>P, which showed metallic conductivity, was close to the ionization potential of ZTP, which indicates the potential barrier against hole transport is small enough at the Cu<sub>3</sub>P/ZTP interface. The resistance was really reduced by the formation of Cu<sub>3</sub>P, while longer annealing made the resistance increase. This might be the reduction of electrode area due to Cu aggregation through interdiffusion. However, by intentionally preparing the Cu<sub>3</sub>P layer between Cu and ZTP, the lowest resistance could be obtained even by short annealing for 5 min. The thickness of the reacted region was larger compared to 15 min-annealed specimens without Cu<sub>3</sub>P insertion. This indicates that Cu<sub>3</sub>P rather worked as a diffusion promoter, which was unexpected. Consequently, the knowledge obtained in the reactive diffusion experiments was applied to solar cell devices, and J-V characteristics of solar cells with intentional insertion of Cu<sub>3</sub>P were close to desirable diode curves without cross-over. Such improvement of back contact led to good reproducibility, and the best efficiency of 3.87 % has been achieved. This work demonstrated that the insertion of a back buffer layer like Cu<sub>3</sub>P, which was well-matched with absorber in the viewpoints of atom configuration and band alignment, is effective to realize Ohmic back contact with low resistance, leading to enhance the cell performance.

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## **3.** DLTS and PL analyses on ZnSnP<sub>2</sub> bulk crystals

#### 3.1. Introduction

ZnSnP<sub>2</sub> (ZTP) has recently attracted much attention as a photo-absorber of thin-film solar cells because of the non-toxic constituents, the suitable bandgap (1.67 eV), and the high absorption coefficient of about  $10^5$  cm<sup>-1</sup> in the visible light region [1,2]. Nakatsuka et al. first demonstrated solar cells using ZTP bulk crystals with the device structure of Al-doped ZnO/CdS/ZTP/Mo, referring to the typical structure of CuInSe<sub>2</sub>-based solar cells, and reported the conversion efficiency of 0.087%[3]. They also discussed the high series resistance of 100  $\Omega$  cm<sup>2</sup> in the above device and proposed the usage of Cu as a back electrode in order to reduce the resistance in the subsequent work [4]. Based on their results, we recently revealed the formation of intermediate compound Cu<sub>3</sub>P, which is wellmatched to ZTP in the viewpoints of band and lattice structures, between ZTP and Cu electrode by heat treatment. Moreover, we have achieved 1.5  $\Omega$  cm<sup>2</sup>, comparable to the resistance of the absorber ZTP, through the electrode structure with Cu<sub>3</sub>P sputtered in advance, and consequently demonstrated the efficiency of 3.87% in ZTP solar cells [5,6]. On the other hand, there is still room for an efficiency improvement much, in particular, a short lifetime of minority carriers in ZTP bulk crystals reported by Nakatsuka et al. [3]. The short circuit current density  $(J_{SC})$  and open-circuit voltage  $(V_{OC})$  in the device with the best efficiency are 12.1 mA cm<sup>-2</sup> and 0.535 V, respectively, and such low performance may come from poor carrier lifetime. The external quantum efficiency (EQE) spectra in ZTP also showed a strong bias dependence in the longer wavelength region, and which indicated an insufficient carrier collection through light absorption in this wavelength region, in other words, a short diffusion length of minority carriers.

In this study, ZTP bulk crystals were characterized by deep level transient spectroscopy (DLTS) and photoluminescence (PL) for discussion on intrinsic defects to improve carrier lifetime. DLTS is well known to be a technique to detect trap levels in semiconductors and has also been applied to

devices recently. Das et al. demonstrated the existence of deep acceptor levels detected by DLTS in  $Cu_2ZnSn(S_xSe_{1-x})_4$  (CZTSSe) solar cells directly affects the performance of solar cells [7]. A further discussion including first-principles calculation on intrinsic point defects such as formation energies and energy levels is fruitful for conventional materials of thin-film solar cells [8] and even for emerging absorber materials such as SnS [9],  $Cu_3N$  [10],  $FeS_2$  [11], and  $Cu_2SnS_3$  [12]. Particularly, a combination of experiments and theory based on defect physics is developing [13], and actually, it was clearly shown that emission observed in a PL spectrum consisted of some recombination processes related to shallow and deep levels in an absorber material  $CuSbS_2$  [14]. The aim of this study is thus to reveal the recombination behavior of minority carriers based on energy levels due to intrinsic defects in ZTP through electric and optical evaluations and theoretical calculation. Note that Kumagai et al. reported first-principles calculation for intrinsic point defects in ZTP and evaluated formation energy and energy level of each defect [15]. In this study, we discuss experimental results by DLTS, PL, and our previous results on time-resolved PL (TRPL) based on their calculation.

# **3.2.** Experimental procedures

ZTP bulk crystals were grown by a solution method using Sn flux as reported by Nakatsuka et al. [16]. The obtained bulk crystals were cut into wafers with a thickness of ~0.8 mm, and both surfaces of each wafer were mechanically polished and chemically treated using 1/2-diluted aqua regia, 1/4-diluted hydrochloric acid, and ultrapure water in this order. For DLTS measurements, we prepared specimens with the structure of Ag/ZTP/Cu<sub>3</sub>P/Cu, where Ag and Cu were adopted as a Schottky and ohmic contact, respectively [4,5]. Cu<sub>3</sub>P thin layer with 25 nm in thickness was prepared on a treated surface by DC sputtering, and then Cu film was also deposited by DC sputtering in the same chamber. After deposition of Cu<sub>3</sub>P and Cu, the specimens were annealed at 673 K for 5 min in an evacuated quartz ampule to reduce the resistance. Subsequently, an Ag electrode was prepared on the opposite

surface of the wafer by conventional thermal evaporation. According to a typical DLTS procedure proposed by Lang [16], the transient capacitances between a certain time,  $t_1$  and  $t_2$ , with various rate windows, expressed by  $\Delta C$ , were evaluated as a function of temperature for Ag/ZTP/Cu<sub>3</sub>P/Cu diodes. The reverse and pulse biases were set at -1.3 and 1.3 V for condition 1, and -1.7 and 1.7 V for condition 2, respectively. The pulse width was 1 ms for both conditions. The temperature was swept from 300 to 80 K. PL measurements were performed at room temperature using a He-Cd laser with the wavelength of 442 nm and the power of 10 mW.

#### 3.3. Results and discussion

Figure 3-1 shows DLTS signals for the Ag/ZTP/Cu<sub>3</sub>P/Cu specimen measured under the conditions 1 and 2. A series of negative signals were observed in condition 1, as seen Fig. 3-1(a), while each spectrum in Fig. 3-1(b) for condition 2 includes negative and positive signals. Since ZTP exhibits a *p*-type conductivity [17], Fig. 3-1 indicates two acceptor-like (hole) traps, A1 and A2, and one donor-like (electron) trap, D1, in ZTP bulk crystal. According to conventional analysis for DLTS [16,18], the activation energy of trap *i*,  $E_{i}$ , is estimated using the following relation,

$$\tau T^2 \propto \exp(E_i / kT), \qquad (3-1)$$

where *T* is the absolute temperature at which  $\Delta C$  takes a maximal or minimal value, *k* is the Boltzmann constant, and  $\tau$  is the time constant defined as

$$\tau = \frac{t_2 - t_1}{\ln(t_2 / t_1)} \,. \tag{3-2}$$

In this study, the ratio,  $t_2/t_1$ , was fixed at 11.5, hence  $\tau$  equals to  $4.3t_1$ . Fig. 3-2 shows an Arrhenius plot derived from DLTS. The activation energies for traps A1, A2, and D1 were estimated to be  $0.12\pm0.01$ ,  $0.65\pm0.13$ , and  $0.21\pm0.02$  eV, respectively. The estimated energies for donor- and acceptor-like traps

correspond to gaps with the conduction band minimum (CBM) edge, Ec, or the valence band maximum (VBM) edge,  $E_v$ . A Diagram of relative energy levels for  $E_c$ ,  $E_v$ , and traps is thus shown in Fig. 3-3. We first discuss the carrier recombination including shallow levels based on the diagram. Figure 4 shows the PL spectrum of a ZTP wafer measured at room temperature. In Fig. 3-4, a sharp emission coming from band-to-band transition is observed around 1.69 eV, of which the peak position is comparable to that reported on a ZTP bulk crystal by Nakatsuka et al. [3], while emission with the small and broad signal is confirmed in the lower energy range. Considering the diagram shown in Fig. 3-3, there are three transition processes in addition to band-to-band recombination in the energy range of PL measurements. We thus analyzed the PL spectrum using Voigt function assuming four transitions: D1 to A1 (DAP), D1 to VBM, CBM to A1, and band-to-band. The results are also shown as blue-dashed and green-solid lines in Fig. 3-4. Peak positions derived from four Voigt functions were 1.29, 1.41, 1.59, and 1.69 eV. The energies for four possible recombination processes in the diagram shown in Fig. 3-3 are 1.36 ( $E_{D1}-E_{A1}$ ), 1.48 ( $E_{D1}-E_{V}$ ), 1.57 ( $E_{C}-E_{A1}$ ), and 1.69 eV ( $E_{C}-E_{V}$ ), which correspond to the energies for respective transitions observed in PL spectrum. Therefore, the results of PL and DLTS coincide with each other. According to the calculation by Kumagai et al. [15], formation energies are significantly low for antisites of Zn on Sn site (Zn<sub>Sn</sub>) and Sn on Zn site (Sn<sub>Zn</sub>), suggesting that they are dominant defects in ZTP. Thermodynamic transition level, TTL, of Sn<sub>Zn</sub> (+2/0) is 0.2 eV below CBM edge, which means antisite of Sn can act as a donor-like defect. On the other hand, antisite of Zn might act as acceptor and lead to p-type conductivity of ZTP, although TTL of  $Zn_{Sn}$  (0/-2) was not clearly confirmed between CBM and VBM in the calculation. It is stated that the formation energy of  $Zn_{sn}^0$  was overestimated in their calculation resulting in lower TTL of  $Zn_{sn}$ . The temperature dependence of hole concentration in ZTP is shown in Figure 3-5, and the activation energy in p-type ZTP is evaluated to be 0.105 eV, which is supported the formation of  $Zn_{Sn}$  as an acceptor defect.



Figure 3-1. DLTS spectra of Ag/ZTP/Cu<sub>3</sub>P/Cu specimen with various  $t_1$ . Reverse bias and pulse bias are (a) -1.3 and 1.3 V and (b) -1.7 and 1.7 V, respectively.



Figure 3-2. Arrhenius plots from DLTS spectra of Ag/ZTP/Cu<sub>3</sub>P/Cu specimen shown in Fig. 3-1.



Figure 3-3. Relatively shallow trap levels detected by DLTS shown with respect to CBM and VBM. The bandgap is determined by PL analysis.



Figure 3-4. Room-temperature PL spectrum of a ZTP bulk crystal.



Figure 3-5. Temperature dependence of hole concentration in ZnSnP<sub>2</sub> crystal. The activation energy is approximately 0.105 eV.

TTLs can be experimentally obtained from DLTS or temperature-dependent Hall effect measurements [19]. In DLTS, TTLs are evaluated from activation energies since it corresponds to thermal ionization energies [20]. Consequently, shallow traps of D1 and A1 come from antisite defects of  $Sn_{Zn}$  and  $Zn_{Sn}$ , respectively. We also discuss A2, the trap with a deep level in the diagram shown in Fig. 3. In the viewpoint of TTL, similarly to the discussion for traps D1 and A1, vacancies of phosphorus and tin, and interstitial defects of zinc and phosphorus should be considered for A2. Among them, the vacancy of phosphorus ( $V_P$ ) and interstitial zinc ( $Zn_i$ ) are rather favorable from their formation energies. First-principles calculation actually suggested that they might show acceptor-like behavior.

Here, we re-discuss a decay curve of TRPL in ZTP bulk crystal reported in our previous work [3]. They analyzed the curve using two components and evaluated minority carrier lifetime to be 0.442 and 37.8 ns. On the other hand, the ratio of the pre-exponential factors of the fast component to slow one was about 10<sup>2</sup>, which implies that almost all minority carriers with light-excited vanished due to fast recombination other than band-to-band. This experimental fact is consistent with the present results showing the presence of A2, the trap with deep energy level, based on the Shockley-Read-Hall theory [21,22].

#### 3.4. Summary of this chapter

In summary, we investigated hole and electron traps in ZTP bulk crystals by DLTS and PL. DLTS analysis revealed three types of traps in ZTP bulk crystal: two with shallow energy levels and the other with a deep level. Hole and electron traps with shallow levels are related to carrier concentration at room temperature, corresponding to so-called donor and acceptor defects, respectively. The previous study based on ab-initio calculation also suggested antisite Sn and Zn might correspond to such defects, respectively, which are favorable in the viewpoint of the formation energy. In the PL spectrum, the sub-gap luminescence in a broad energy range was observed, and it was understood the spectrum contained four recombinations related to CBM, VBM, and the above acceptor and donor levels. On the other hand, the trap with a deep energy level might come from phosphorus vacancy or Zn interstitials, and the presence of such a trap is also suggested in the TRPL decay of our previous work. The formation energy of such defects by calculation is relatively high in ZTP, and it is an advantage as an absorber in solar cells. However, the discussion on DLTS is slightly inconsistent with theoretical studies. This might be from the chemical environment, in other words, chemical potentials of constituent elements, in preparation of bulk crystals, which should be considered and investigated in future works.

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### 4. Raman spectroscopy on ZnSnP<sub>2</sub> with various degrees of order

#### 4.1. Experimental procedures

#### 4.1.1. Bulk crystal growth

ZnSnP<sub>2</sub> bulk crystals with various degrees of order were prepared according to our previous report [1]. Starting materials, zinc shots (99.9999% purity, Kojundo Chemical Laboratory), tin shots (99.99% purity, Kojundo Chemical Laboratory), and red phosphorus flakes (99.9999% purity, Kojundo Chemical Laboratory), were sealed in evacuated quartz ampules with inner diameters of 11 mm under a pressure of  $10^{-2}$  Pa. The overall weight of the materials was about 60 g, and the nominal molar composition was 92 mol%Sn, 2.7 mol%Zn and 5.3 mol%P. The ampules were then heated up to 700 °C and kept for 12 hours for homogenization. After homogenization, the ampules were unidirectionally cooled from the bottom at different rates of 0.7-640 °C h<sup>-1</sup> to obtain specimens with various degrees of order in the cation sub-lattice. For a specimen with a cooling rate of 0.7 °C  $h^{-1}$ , bulk crystals precipitating at the bottom of the ingot were then cut into wafers with a thickness of about 1 mm using a diamond wheel saw. Some wafers were then mechanically polished with emery papers and a buff-sheet, and the others were ground into powder with an agate mortar and a pestle for following characterizations. For the specimens with other cooling rates in which small ZnSnP<sub>2</sub> dispersed around in ingots, Sn flux was dissolved by NaCl-added nitric acid. NaCl was added as a supplier of chlorine ions for the formation of tin chloride complex. After completely dissolving Sn flux, the solvent was filtered and ZnSnP<sub>2</sub> flakes were collected. Those flakes were ground into powder as done for wafers, with remaining some of them as collected for following measurements.

#### 4.1.2. Characterizations

X-ray diffraction (XRD) were measured for all types of samples, such as wafer, flake, and powder, by the equipment (X'Pert Pro Alpha-1, PANalytical) and conditions; using  $CuK\alpha_1$  ( $\lambda = 1.5406$
Å) with the tube voltage and current of 45 kV and 40 mA, respectively, in the Bragg-Brentano ( $\theta$ -2 $\theta$ ) configuration. Raman spectra were measured with laser Raman spectrometer (NRS-3100 for powder and NRS-5500 for wafers and flakes, JASCO). The laser diameter of ~1 µm and resolution of ~1 cm<sup>-1</sup> in wavenumber. The laser wavelength was 532 nm. Compositions of flakes were analyzed by scanning electron microscopy (SEM; JCM-600Plus, JEOL) equipped with energy-dispersive x-ray spectroscopy (EDS; MP-05030EDK, JEOL). In EDS analysis, we used a bulk crystal of ZnSnP<sub>2</sub> as a standard, supposing ZnSnP<sub>2</sub> is a line compound. Optical properties were analyzed based on transmittance and diffuse reflectance measurements (UV-2600, SHIMADZU) and ellipsometry (UVISEL, HORIBA). Chemical states were analyzed for all types of samples by x-ray photoelectron spectroscopy (XPS; ESCA-3400HSE, SHIMADZU) using Mg K $\alpha$  with the acceleration voltage of 10 kV and emission current of 20 mA under pressure less than 10<sup>-6</sup> Pa before and after etching surface. The surface etching was done by Ar gas with the pressure of 4×10<sup>-3</sup> Pa, the acceleration voltage of 0.5 kV, and the emission current of 20 mA.

# 4.2. Results and discussion

Figure 4-1 shows XRD profiles of the powder specimens obtained by grinding wafer and flake obtained from ingots grown with the cooling rate of 0.7 and 640 °C h<sup>-1</sup>, respectively. The pictures of the wafer and flake are also shown. Both XRD profiles indicate the presence of only ZnSnP<sub>2</sub> while the intensity of the superlattice reflection is higher for the lower cooling rate than those for the higher one. A stronger superlattice reflection indicates a higher degree of order [1]. Thus, the degree of order in the wafer is higher than that in the flake. It has also been reported that a high degree of order resulted in a wider bandgap [1]. Figure 4-2 Transmittance spectra and Tauc plots for the wafer and flake ZnSnP<sub>2</sub>. Tauc plots were calculated, supposing that the absorption edge of ZnSnP<sub>2</sub> is associated with a direct-



Figure 4-1. (a)XRD profiles of powder specimens with cooling rates of 0.7 and 640 °C  $h^{-1}$ , respectively corresponding to (b) wafer and (c) flake.



Figure 4-2. Diffuse reflectance and/or transmittance spectra of (a) wafer and (b) flake specimens, and the Tauc plot for (c) wafer and (b) flake specimens.

transition from the valence band maximum (VBM) to the conduction band minimum (CBM) at the  $\Gamma$ point in **k**-space [2]. The optical bandgap of the wafer specimen is about 1.6 eV, while that of the flake one is about 1.3 eV, which reflects the degree of order.

Figure 4-3 shows Raman spectra and fitting curves for wafer, flake, and powder ZnSnP<sub>2</sub> with various cooling rates. As shown in Fig. 4-3 (a), fitting analysis for the wafer resulted in four sharp peaks with Raman shifts of 308.3, 327.9, 342.4, and 365.3 cm<sup>-1</sup>. In this study, Gaussian seems more favorable for fitting analyses than Lorentzian, maybe due to the broadness of observed peaks. Compared to the values of Raman shifts reported by Mintayrov et al. [3], these peaks can be assigned to the vibration modes of chalcopyrite ZnSnP<sub>2</sub>,  $\Gamma_1$ ,  $\Gamma_{5T}$ ,  $\Gamma_{5T}$ , and  $\Gamma_{4L}$ , respectively. The notations of vibration modes are referred to in the report by Mintairov et al. [3] and Kaminow et al. [4]. According to them, the vibration mode of  $\Gamma_1$  is associated only with the displacement of P atoms, while  $\Gamma_{5T}$  and  $\Gamma_{4L}$  include those of Zn and Sn atoms as well. A study of nuclear magnetic resonance by Ryan et al. indicated that when cation-ordering occurs, the tetrahedral coordination around P-toms deviates from the most stable electrically state of the perfectly-ordered ZnSnP<sub>2</sub> [5]. Namely, the combination of the number of the first nearest Zn and Sn atoms around each P atom changed from 2 Zn and 2 Sn, for example, to 1 Zn and 3 Sn or vice versa. On the other hand, the tetrahedral coordination around each cation is invariant under cation-disordering: Zn and Sn atoms are surrounded by 4 P atoms. This implies that vibration modes associated with the displacement of P atoms may change sensitively with cation-disordering. Fig. 4-3(b) shows the Raman spectrum of the flake, for which five peaks are found by fitting analysis. Two peaks at 310.9 and 358.3 cm<sup>-1</sup> are likely  $\Gamma_1$  and  $\Gamma_{4L}$  modes, respectively, which are common peaks for the wafer. However, the relative intensity of  $\Gamma_1$  is much lower for the flake than that of the wafer. As discussed above,  $\Gamma_1$  is associated only with the displacement of P atoms, but  $\Gamma_{4L}$ includes those of Zn and Sn as well. The weakening of the  $\Gamma_1$  mode may reflect the decrease of the degree of order. Such behavior of  $\Gamma_1$  mode was observed in the polarized Raman spectra of thin-film

ZnSnP<sub>2</sub> epitaxially grown on GaAs substrate [3]. In contrast to  $\Gamma_1$ ,  $\Gamma_{4L}$  seems less sensitive to the difference of the degree of order probably because  $\Gamma_{4L}$  includes the displacement of not only P but also Zn and Sn atoms. Camassel et al. [6] and Artus et al. [7] reported based on group theoretical analyses that  $\Gamma_{4L}$  is a zone-center Raman-active mode for both space groups  $T_d^2$  and  $D_{2d}^{12}$ , indicating that  $\Gamma_{4L}$  appears for both perfectly-disordered and -ordered ZnSnP<sub>2</sub>. On the other hand, two peaks at 295 and 333 cm<sup>-1</sup> in the Raman spectra of the flake are not observed for the wafer. Considering the low degree of order of the flake, these peaks are rather assigned to  $\Gamma_2$  mode, which is Raman-inactive in the perfectly-ordered ZnSnP<sub>2</sub> but allowed when the cation-disordering is remarkable [3]. The large FWHM for the flake specimen can also be explained by cation-disordering. In ZnSnP<sub>2</sub>, a decrease in the degree of order directly corresponds to the increase of the concentration of cation antisites such as Zn on Sn site (Zn<sub>Sn</sub>) and Sn on Zn site (Sn<sub>Zn</sub>). Generally, an increase in defect concentration leads to



Figure 4-3. Raman spectra of various types of ZnSnP<sub>2</sub>. (a) Wafer, (b) flake, and (c) powder grown with different cooling rates.

enhancement of damping effects and results in weakening and broadening of Raman peaks. Spatial correlation model by Parayanthal and Pollak also suggests that disorder-induced potential fluctuation leads to broadening of Raman line shape [8]. The small peak at 280 cm<sup>-1</sup> could not be assigned to the reported vibration mode for ZnSnP<sub>2</sub>.

Figure 4-3(c) shows Raman spectra of powder ZnSnP<sub>2</sub> with various degrees of order confirmed by Nakatsuka and Nose [1]. The peak FWHM is much larger than those of the wafer specimen mainly due to the scattering by much stress and defects induced during grinding. Fitting analyses found four peaks at 302.3±1.8, 318.6±2.2, 331.7±2.7, and 350.6±2.0 cm<sup>-1</sup>. As is the case for the wafer, they can be assigned to  $\Gamma_1$ ,  $\Gamma_{5T}$ ,  $\Gamma_{5T}$ , and  $\Gamma_{4L}$  modes, respectively.  $\Gamma_1$  mode in powder ZnSnP<sub>2</sub> exhibits a similar trend to those in wafer and flake: the peak intensity of  $\Gamma_1$  seems to increase with the decrease in the cooling rate and hence increase in the degree of order.

For more quantitative discussion, the fitting parameters to Raman spectra of all types of specimens are summarized in Figure 4-4: FWHM of  $\Gamma_1$  and  $\Gamma_{4L}$  ( $\Gamma_{15}$ ) peaks and area- and height-ratio of  $\Gamma_1$  to  $\Gamma_{4L}$  ( $\Gamma_{15}$ ). Figure 4-4(a) shows the parameters for the wafer and flake specimens, corresponding



Figure 4-4. FWHM and normalized peak area and intensity evaluated by Gaussian fitting to Raman spectra of (a) bulk and (b) powder ZnSnP<sub>2</sub> grown with various cooling rates.

to high and low degrees of order, respectively. FWHM is smaller and area- and height-ratio is higher for the wafer than for the flake. Figure 4-4(b) shows the fitting parameters for powder specimens. As is the case for wafer and flake, FWHM of both  $\Gamma_1$  and  $\Gamma_{4L}$  decrease with the decrease of cooling rate. The decrease in the FWHM may be explained by the reduction of the damping effect or potential fluctuation due to cation antisites. On the other hand, the peak area ratio does not change monotonically with the degree of order, which takes a maximum at 15 °C h<sup>-1</sup>. It can be considered that when the degree of order becomes higher than a certain value, a further reduction of the cation antisites makes the momentum conservation rule of Raman scattering stricter. In this case, phonons with nonzero momentum are not allowed to participate in the first-order Raman scattering process [9], which may cause a decrease in the total number of phonons involved and result in a decrease in the peak area. Generally, the peak area of the Gaussian function is proportional to the product of the FWHM and the peak height. Thus, the small change of the peak height ratio in the range of the cooling rate between 15 and 0.5 °C h<sup>-1</sup> results from the balance of the FWHM and the area ratio. These results partly suggest that Raman spectroscopy can be used to evaluate the degree of order of ZnSnP2. However, it is also implied that a more comprehensive and quantitative model should be established, such as taking the grind-induced stress into account.

# 4.3. Summary of this chapter

In the present study, bulk and powder  $ZnSnP_2$  with various degrees of order are characterized by non-polarized Raman spectroscopy. The ordered wafer exhibits a sharp and strong peak of the  $\Gamma_1$ mode, while the disordered flake exhibits a weak and broad one, which is consistent with the report by Mintairov et al. Systematic changes of the peak intensity, area, and FWHM are also confirmed for the  $\Gamma_1$  mode in powder samples with different long-range order parameters. These results partly suggest that Raman spectroscopy can be used to evaluate the degree of order of  $ZnSnP_2$ . However, it is also implied that a more comprehensive and quantitative model should be established, such as taking the grind-induced stress into account.

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# 5. MBE growth of thin-film ZnSnP<sub>2</sub>

# 5.1. Experimental procedures

#### 5.1.1. Thin-film growth

Thin-film ZnSnP<sub>2</sub> was grown by MBE using effusion cells. Zn and Sn vapors were supplied from pure metal sources, while P<sub>4</sub> vapor was from Sn<sub>4</sub>P<sub>3</sub>/Sn composites as reported before [1]. Beam equivalent pressures (BEP) of each vapor were measured by a beam flux monitor with a nude ion gage of an yttria coated iridium filament and a platinum-clad molybdenum wire gird (NIG-2TF 954-7903, Canon Anelva). BEPs of Zn, Sn, and P<sub>4</sub> vapors were set at about  $8.5 \times 10^{-6}$ ,  $1.5 \times 10^{-5}$ , and  $1.8 \times 10^{-2}$  Pa, which are modified values from those used in the previous study [2]. All elements were co-supplied for a deposition period of 120 min in all depositions. Soda-lime glass substrates were used and the substrate temperature was measured by a pyrometer (KTL Pro, LEC). The accuracy of the pyrometer was confirmed by the fact that thin-film Sn was melted at the measured temperature of ~230 °C, near the melting temperature of Sn (232 °C). Here, the measured temperature by the pyrometer is called growth temperature, *T*<sub>G</sub>. The employed growth temperatures were 200–320 °C.

## 5.1.2. Characterizations

Grazing incidence x-ray diffraction (GI-XRD) was measured by standard equipment (Empyrean, Malvern PANalytical) using CuK $\alpha_1$  ( $\lambda = 1.5406$  Å) as a source with the tube voltage and current of 45 kV and 40 mA, respectively. The incident angle  $\omega$  was 0.5°. Raman spectra were measured with a laser Raman spectrometer (NRS-3100, JASCO). Magnification, exposure time, and laser power were the same for all films. The composition of films were analyzed by scanning electron microscopy (SEM; JCM-600Plus, JEOL) equipped with energy-dispersive x-ray spectroscopy (EDS; MP-05030EDK, JEOL). For EDS analysis, the wafer ZnSnP<sub>2</sub> was used as a standard with supposing the molar ratio, Zn:Sn:P, is 1:1:2. The thickness of the films was measured by a stylus profiler (Dektak

6M, Veeco). Optical properties were analyzed based on transmittance and diffuse reflectance measurements (UV-2600, SHIMADZU) and ellipsometry (UVISEL, HORIBA). Electrical properties of films were measured by the van der Pauw method with an AC magnetic field of 0.33 T using a resistivity and Hall-effect measurement system (Resitest8300, Toyo Corporation). The microstructure of films was observed by field-emission scanning electron microscopy (FE-SEM; JSM-6500F, JEOL). Chemical states were analyzed by x-ray photoelectron spectroscopy (XPS; ESCA-3400HSE, SHIMADZU) using Mg K $\alpha$  line with the acceleration voltage of 10 kV and emission current of 20 mA under pressure less than 10<sup>-6</sup> Pa. The XPS measurements were carried out before and after etching the sample surface by Ar gas with the pressure of  $4 \times 10^{-3}$  Pa, the acceleration voltage of 0.5 kV, and the emission current of 20 mA.

# 5.2. Results and discussion

## 5.2.1. Phase identification of thin-films

Figure 5-1 shows XRD profiles of thin films grown by MBE at different temperatures. There is no peak in the profile for 205 °C, while several peaks are confirmed for above 231 °C. The intensity and width of the peak at ~27° repectively get higher and smaller with the increase in the growth temperature. This indicates the increase in the crystallinity of films. The Diffraction angles are well matched to those of the reference pattern of chalcopyrite  $ZnSnP_{2.}$ , although no superlattice reflection could be observed. It seems that the degree of order in the obtained  $ZnSnP_{2}$  is much low. Peaks at other diffraction angles exhibit similar dependence on the growth temperature to the peak at ~27°.

Figure 5-2 shows the EDS compositions of Zn, Sn, and P for the various growth temperatures between 231–317 °C. P composition is almost constant at 46 mol% in the whole range, while Zn and Sn compositions change between 20–30 mol% depending on the growth temperature. Although these compositions are not totally consistent with that of stoichiometric ZnSnP<sub>2</sub>, off-stoichiometry of MBE- grown ZnSnP<sub>2</sub> was confirmed elsewhere [3,4], maybe due to some kinetic effects. Considering the XRD and EDS results, films above 230 °C are likely to be ZnSnP<sub>2</sub>. Small Zn/Sn ratio at high growth temperature is due to the gap of desorption rates between two cations: the much higher desorption rate and lower nominal deposition rate of Zn than those of Sn. Although the same trend was also expected



Figure 5-1. XRD profiles of MBE films with different growth temperatures.



Figure 5-2. EDS compositions of Zn, Sn, and P for thin-films grown by MBE at 231–317 °C.

for P not only for Zn, the large BEP of phosphorus rather dominates the deposition rate than the desorption rate does, resulting in a small dependence of P composition on the growth temperature.

## 5.2.2. Raman spectra of thin-film ZnSnP<sub>2</sub>

Figure 5-3 shows Raman spectra of thin-film ZnSnP<sub>2</sub>. Compared to the spectra of bulk and powder ZnSnP<sub>2</sub> discussed in the previous chapter, further broader peaks are observed, of which FWHM is 20–70 cm<sup>-1</sup>. Similar broad Raman peaks are also reported for nanowire ZnSnP<sub>2</sub> [5,6]. As discussed later, FE-SEM observation reveals the grain size of the present films is less than 50 nm. Thus, the broad peaks are the features of small grain size. It was found by fitting analysis that each peak consists of two components over the whole temperature range. Interestingly, peak locations seem changed at a certain growth temperature; two  $\Gamma_2$  at about 290 and 330 cm<sup>-1</sup> below 257 °C while  $\Gamma_1$  at ~320 cm<sup>-1</sup> and  $\Gamma_{4L}$  at ~350 cm<sup>-1</sup> above 270 °C. Since  $\Gamma_2$  is a disorder-activated vibration mode as



Figure 5-3. Raman spectra of thin-film ZnSnP<sub>2</sub> grown by MBE at different temperatures.



Figure 5-4. Fitting parameters for Raman spectra of thin-film ZnSnP<sub>2</sub> grown above 260 °C. mentioned above, films grown below 257 °C are disordered ZnSnP<sub>2</sub>. Taking account of the much broad peak of GI-XRD, films grown below 257 °C were rather amorphous. On the other hand, the presence of  $\Gamma_1$  and  $\Gamma_{4L}$  peaks indicate that films grown above 270 °C have higher degrees of order. Yet the degree of order is not high enough to evolve superlattice reflection, Raman spectroscopy may detect a slight change even for such a low degree of order. Fig. 5-4 shows the dependence of fitting parameters for thin-film specimens on the growth-temperature above 270 °C. With the increase in growth temperature, the FWHM decreases while the area and intensities of peaks increases. This may reflect the increase in the crystallinity and, considering the case of the bulk and the powder ZnSnP<sub>2</sub> discussed before, partly the increase in the degree of order.

## 5.2.3. Optical measurements

Figure 5-5 shows transmittance, diffuse reflectance, and absorption coefficients of thin-film grown by MBE. Here, the absorption coefficient  $\alpha$  was calculated from the following equation;

$$\alpha = \frac{1}{d} \ln \left[ \frac{\left(1 - R\right)^2}{T} \right],\tag{5-1}$$

where R and T are the measured diffuse reflectance and transmittance divided by 100, respectively. d

is the thickness measured by the stylus, of which the temperature dependence is shown in Figure 5-7. From both transmittance and diffuse reflectance spectra, any obvious absorption edge cannot be confirmed. On the other hand, the absorption coefficients increase abruptly around 0.9–1.2 eV. In addition, the absorption edge seems to shift toward the high-energy side with the increase in the growth temperature. This indicates the increase in the bandgap of the thin-film ZnSnP<sub>2</sub> and hence the degree of order. However, it was found that the absorption coefficients take negative values in the low energy region. Because of this, exact absorption edges could not be calculated. Such negative values might be attributed to the inaccuracies in measurement or mismatch of the analysis model. More precise measurements are thus desired for the determination of the absorption edge and hence the bandgap.

Figure 5-6 shows the optical constants evaluated by fitting to the spectra of  $\tan \Psi$  and  $\cos \Delta$  measured by ellipsometry.  $\Psi$  and  $\Delta$  the azimuth and the phase difference. In the analysis, we assumed that the obtained films consist of stacking of a surface-roughness layer (SRL), ZnSnP<sub>2</sub>, and soda-lime glass substrate and fitting thicknesses, refractive indices *n*, and distinction coefficients  $\kappa$  of SRL and



Figure 5-5. (a) Transmittance, (b) diffuse reflectance, and (c) absorption spectra measured on thin-film ZnSnP<sub>2</sub> grown by MBE.

ZnSnP<sub>2</sub>. The thickness of the substrate is fixed at 0.5 mm. As shown in Fig. 5-6(a) and (b), the optical constants n and  $\kappa$  for the growth temperature less than 257 °C have no distinct peak in the whole energy range, which indicates these films are more amorphous-like. On the other hand, those for above 271 °C exhibits small peaks in the range of 1–2 eV. These peaks may be associated with absorption, indicating the presence of the band structure in the films. This is consistent with the increase in the crystallinity indicated by both GI-XRD and Raman spectra. In addition, the peak energy slightly increases with the increase in the growth temperature. Similar trend is confirmed in the absorption coefficient as discussed above. The discrepancy between the absorption coefficient evaluated by ellipsometry and that by transmittance and diffuse reflectance may come from the inaccuracies of the measurements or the inherent difficulty in fitting for ellipsometry.



Figure 5-6. (a) Refractive indices, (b) distinction coefficients, and (c) absorption coefficients of thin-film ZnSnP<sub>2</sub> with different growth temperatures. Those of bulk ZnSnP<sub>2</sub> are also shown for a comparison.



Figure 5-7. (a) The growth temperature dependence of the thickness of surface roughness layer (SRL) and ZnSnP<sub>2</sub>. (b) The stacking model used in the analysis of ellipsometry.

#### 5.2.4. Ordering in the growth of thin-film ZnSnP<sub>2</sub>

As pointed out in several studies, the degree of order in ZnSnP<sub>2</sub> depends on the growth conditions like cooling rates for bulk crystals [7–9]. The order-disorder transition temperature of ZnSnP<sub>2</sub> is assumed to be 993 K or higher [10,11], which is much higher than the growth temperatures for bulk and thin-film ZnSnP<sub>2</sub>. Thus, nearly perfectly-ordered chalcopyrite ZnSnP<sub>2</sub> should be obtained in experiments thermodynamically, and disordered chalcopyrite or sphalerite phases are products of kinetic effects. For bulk crystals grown from the solution of Zn and P in Sn flux, a low degree of order is obtained at a fast cooling-rate, which means an insufficient period for ordering results in an unstable random distribution of Zn and Sn atoms on the cation sub-lattice. For thin-film growth, on the other hand, deposition periods fixed at 120 min and high growth temperature lead to a high degree of order. It is hence considered that sufficient time and temperature are needed for the high degree of order.

In addition to time and temperature, Sn-content may influence cation-ordering in the thin-film growth of ZnSnP<sub>2</sub>. As discussed in Fig. 5-2, the molar ratio of Sn/Zn varies from 0.82 to 1.46 with the increase in the growth temperature. Seryogin et al. suggested that the increase in BEP ratio of Sn/Zn in MBE leads to the presence of liquid Sn and the change of the growth mode from solid-vapor to

solid-liquid-vapor growth [12]. Elyukin and Temkin mentioned, based on a thermodynamical calculation, that the solid-liquid contact reduces the energy barrier to crystallization, resulting in much smaller supercooling, which is a favorable condition for a high degree of order [13]. Liquid Sn can exist in this study, too, since the melting point of Sn (232 °C) is almost below the subjected growth-temperature range of 231–317 °C. Therefore, the increase in the degree of order indicated by Raman spectroscopy on thin-film ZnSnP<sub>2</sub> may be influenced by the increase of Sn-content and the presence of liquid Sn. Considering the case of the deposition of chalcopyrite CuInSe<sub>2</sub> through liquid Cu-Se [14], it may be a common phenomenon that a liquid phase assists cation-ordering during thin-film growth. The influence of Sn-content on the growth mode is indicated by the growth temperature dependence of the thickness of SRL and ZnSnP<sub>2</sub> evaluated from ellipsometry. As shown in Figure 5-7, the thickness of the surface roughness layer is much larger for above 260 °C than that for below 260 °C, which indicated the surface roughness abruptly changes at that temperature. Such an abrupt change around 260 °C is also confirmed in Raman spectra in Figure 5-3 and the optical constants in Figure 5-6.

#### 5.2.5. Electrical properties

Figure 5-8 shows resistivity of thin-film ZnSnP<sub>2</sub> grown by MBE at different temperatures. The resistivity is higher than 100  $\Omega$  cm for all films. Such high resistivity and small thickness (<250 nm) led to high sheet resistance over 10<sup>6</sup>  $\Omega$  sq., which caused huge noise in Hall effect measurements and hindered the determination of carrier type, concentration, and mobility. As shown in Figure 5-9, it was found by the surface FE-SEM observation that the average grain size of the films is less than 50 nm. Moreover, XPS analysis in the depth direction with Ar etching revealed much content of oxygen in the whole film. Considering both grain boundary and oxygen content can cause carrier-scattering, it is desired to enlarge grain size and remove oxygen in order to reduce the resistivity.



Figure 5-8. Resistivity of thin-film ZnSnP<sub>2</sub> grown by MBE at different temperatures.



Figure 5-9. Surface FE-SEM images of thin-film ZnSnP<sub>2</sub> grown at (a) 231, (b) 248, (c) 257, (d) 270, (e) 291, and (f) 317 °C.

## 5.3. Summary of this chapter

In the present study, thin-film ZnSnP<sub>2</sub> was grown by MBE at different temperatures. GI-XRD indicates crystalline but much disordered ZnSnP<sub>2</sub> were obtained above 231 °C and the crystallinity increases with the increase in the growth temperature. EDS analysis revealed that the composition of the obtained ZnSnP<sub>2</sub> is different than the stoichiometry and the cation composition ratio Zn/Sn decreases with the increase in the temperature. Raman spectra of films grown below 257 °C show two peaks of the  $\Gamma_2$  mode, a disorder-activated vibration mode, while those for above 270 °C includes two peaks of  $\Gamma_1$  and  $\Gamma_{4L}$ . In addition, the peak intensities of both  $\Gamma_1$  and  $\Gamma_{4L}$  increase with the increase in the growth temperature. These results of Raman spectroscopy indicate the increase in the crystallinity or the degree of order. From optical measurements, the absorption edge seems to shift toward the high-energy side with the increase in the growth temperature. It may reflect the increase in the degree of order. The presence of liquid Sn might be correlated to the ordering in thin-film ZnSnP<sub>2</sub>. Measurements of carrier type, concentration, and mobility were difficult because of the high resistance probably due to the small grain size and oxygen contents, which must be improved for application.

#### **References to Chapter 5**

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# 6. General conclusion

#### Cu<sub>3</sub>P back buffer layer for ZnSnP<sub>2</sub> solar cells

Re-investigation on the reactive diffusion at the Cu/ZTP interface revealed that the epitaxial formation of Cu<sub>3</sub>P beside ZTP through annealing at 400 °C. The electron diffraction analyses revealed the epitaxial relationship of Cu<sub>3</sub>P [1100](0001)//ZTP [110](112). In addition, the estimated latticemismatch was less than 0.5% on the common triangular arrangements of phosphorus sublattice in both crystal planes. On the other hand, the work function of Cu<sub>3</sub>P was close to the ionization potential of ZTP, which indicates the potential barrier against hole transport is small enough at the  $Cu_3P/ZTP$ interface. However, the resistance was reduced by the formation of Cu<sub>3</sub>P, while longer annealing resulted in an increase in resistance. This might be due to the reduction of electrode area associated with Cu aggregation through interdiffusion. Successfully, by sputtering of Cu<sub>3</sub>P on ZTP before the deposition of Cu, we could obtain the lowest resistance by annealing even for 5 min. Interestingly, the thickness of the reacted region was larger than 15 min-annealed specimens without Cu<sub>3</sub>P insertion. This indicates that Cu<sub>3</sub>P rather worked as a diffusion promoter than a diffusion barrier. Consequently, the J-V characteristics of solar cells with intentionally-inserted Cu<sub>3</sub>P were close to desirable diode curves; there was no cross-over behavior confirmed in the previous cells. Such improvement of back contact led to good reproducibility and the best efficiency of 3.87 %. This work demonstrated the utility of a "self-organized back-buffer layer" like Cu<sub>3</sub>P, which is spontaneously formed so as wellmatched to absorber in the viewpoints of both atomic configuration and band alignment, for the realization of low resistive ohmic contact.

#### DLTS and PL analyses on ZnSnP<sub>2</sub> bulk crystals

Hole and electron traps in ZTP bulk crystals were investigated by DLTS and PL. DLTS analysis revealed three types of trap in ZTP bulk crystal: two with shallow energy levels and the other with a

deep level. Hole and electron traps with shallow levels correspond to so-called donor and acceptor defects, respectively. The previous first-principles study suggested antisite  $Zn_{Sn}$  and  $Sn_{Zn}$  might be origins of such defects, respectively, in the viewpoint of the formation energy. In the PL spectrum, the sub-gap luminescence in a broad energy range was observed, which could be understood by supposing the spectrum contained four recombinations related to CBM, VBM, and the above acceptor and donor levels. On the other hand, the trap with a deep energy level might come from  $V_P$  or  $Zn_i$ . The presence of such a deep defect level was implied by the rapid TRPL decay confirmed in our previous work. However, the calculated formation energy of the deep-level defects is not so small, which is slightly inconsistent with the discussion on DLTS. This might be from the discrepancy of the chemical environment, in other words, chemical potentials between the calculation and the actual growth of bulk crystals. It should be investigated in future works.

#### Raman spectroscopy on ZnSnP<sub>2</sub> with various degrees of order

Bulk and powder ZnSnP<sub>2</sub> with various degrees of order are characterized by non-polarized Raman spectroscopy. The ordered wafer exhibits a sharp and strong peak of the  $\Gamma_1$  mode while the disordered flake exhibits a weak and broad one, which is consistent with the report by Mintairov et al. Systematic changes of the peak intensity, area, and FWHM are also confirmed especially for the  $\Gamma_1$ mode in powder samples with different long-range order parameters. This may suggest that Raman spectroscopy can be used for the evaluation of the degree of order of ZnSnP<sub>2</sub>, although it is also implied that more quantitative investigation are needed.

### MBE growth of thin-film ZnSnP<sub>2</sub>

Thin-film ZnSnP<sub>2</sub> was grown by MBE with different growth temperatures. For the films obtained above 231 °C, XRD patterns are well assigned to chalcopyrite ZnSnP<sub>2</sub>, although there is no

superlattice reflection. This indicates the obtained thin films are ZnSnP<sub>2</sub> with a much low degree of order. The peak width is smaller and the intensity is larger for the higher growth temperature, which indicates the increase in the crystallinity. EDS composition of Zn decreases with the increase in the growth temperature while that of Sn increases probably because of the much higher vapor pressure and desorption rate of Zn than those of Sn. Considering the similar off-stoichiometry repoted in the previous studies of thin-film growth of ZnSnP<sub>2</sub>, it would be plausible that ZnSnP<sub>2</sub> with a offstoichimetric composition is kinetically obtained. Raman spectra of the films grown below 260 °C show two peaks of the disorder-activated  $\Gamma_2$  mode, while those for above 271 °C show  $\Gamma_1$  and  $\Gamma_{4L}$ . Such a change of the observed vibration modes may originate from the decrease in defects, i.e., cationantisites. The increase in the intensity of both modes with the increase in the growth temperature is consistent with the increase in the crystallinity indicated by GI-XRD. The increase in the crystallinity is also indicated by ellipsometry. The absorption edge shifts toward the high-energy side with the increase in the growth temperature, which may be associated with the decrease in the cation antisites. Finally, it is mentioned, as a possible mechanism of thin-fim growth of ZnSnP<sub>2</sub>, that the presence of liquid Sn indicated by the increase in the Sn/Zn composition ratio also supports the ordering in thinfilm ZnSnP<sub>2</sub>.

# Achievements

## Journal articles

"Performance enhancement of ZnSnP<sub>2</sub> solar cells by a Cu<sub>3</sub>P back buffer layer" <u>Taro Kuwano</u>, Ryoji Katsube, Kenji Kazumi, Yoshitaro Nose *Solar Energy Materials & Solar Cells* **221** 110891 (2021). https://doi.org/10.1016/j.solmat.2020.110891

"Deep level transient spectroscopy and photoluminescence studies of hole and electron traps in ZnSnP<sub>2</sub> bulk crystals"

<u>Taro Kuwano</u>, Ryoji Katsube, Steve Johnston, Adele C. Tamboli, Yoshitaro Nose Japanese Journal of Applied Physics (accepted) https://doi.org/10.35848/1347-4065/ac468a

## **Conference proceedings**

"Impact of structure on carrier transport behavior at the interface between electrode and ZnSnP<sub>2</sub> absorber" <u>Taro Kuwano</u>, Shigeru Nakatsuka, Yoshitaro Nose *IEEE 7th World Conference on Photovoltaic Conversion*, 2998–2999 (2018). https://doi.org/10.1109/PVSC.2018.8547478

"Improvement of Ohmic Behavior of Back Contact in ZnSnP<sub>2</sub> Solar Cells by Inserting Cu<sub>3</sub>P" <u>Taro Kuwano</u>, Ryoji Katsube, Yoshitaro Nose *IEEE 46th Photovoltaic Specialists Conference*, 3007–3009 (2019). https://doi.org/10.1109/PVSC40753.2019.8980788

# International conference presentation

"Effect of Interfacial Compounds between Back Electrode and Absorber on Performance of ZnSnP<sub>2</sub> Solar Cells"

T. Kuwano, S. Nakatsuka, Y. Nose

27th International Photovoltaic Science and Engineering Conference (PVSEC-27), November 2017

"Impact of structure on carrier transport behavior at the interface between electrode and ZnSnP2 absorber"

T. Kuwano, S. Nakatsuka, Y. Nose

7th World Conference on Photovoltaic Energy Conversion (WCPEC-7), June 2018.

"Interface Structure and Carrier Transport Behavior between Cu Electrode and ZnSnP<sub>2</sub> Absorber" <u>Taro Kuwano</u>, Shigeru Nakatsuka, Yoshitaro Nose International Symposium on Solar Energy Materials, January 2019.

"Improvement of Ohmic Behavior of Back Contact in ZnSnP<sub>2</sub> Solar Cells by Inserting Cu<sub>3</sub>P" <u>T. Kuwano</u>, R. Katsube, Y. Nose 46th IEEE Photovoltaic Specialists Conference (PVSC-46), June 2019.

"Photoluminescence and Deep Transient Spectroscopy for ZnSnP<sub>2</sub> Bulk Crystals"
 <u>T. Kuwano</u>, R. Katsube, S. Johnston, A. C. Tamboli, Y. Nose
 30th International Photovoltaic Science and Engineering Conference (PVSEC-30), November 2020.

"Impact of substrate temperature on bandgap in ZnSnP<sub>2</sub> thin films by MBE" <u>Taro Kuwano</u>, Yoshitaro Nose 31st International Photovoltaic Science and Engineering Conference (PVSEC-31), December 2021.

### **Domestic conference presentation**

"ZnSnP<sub>2</sub>吸収層とCu裏面電極との接合の界面構造とキャリア輸送"
 <u>桑野太郎</u>、勝部涼司、野瀬嘉太郎
 第79回応用物理学会秋季学術講演会、2018年9月

"ZnSnP<sub>2</sub>吸収層/Cu 電極界面への Cu<sub>3</sub>P 層の導入による直列抵抗の低減" <u>桑野太郎</u>、勝部涼司、野瀬嘉太郎 第 66 回応用物理学会春季学術講演会、2019 年 3 月

"ZnSnP<sub>2</sub>太陽電池の裏面電極構造"
 <u>桑野太郎</u>、勝部涼司、野瀬嘉太郎
 第16回「次世代の太陽光発電システム」シンポジウム、2019年7月

"ZnSnP<sub>2</sub>吸収層/Cu 電極界面への Cu<sub>3</sub>P の挿入による太陽電池の直列抵抗低減と変換効率向上" <u>桑野太郎</u>、勝部涼司、野瀬嘉太郎 第 80 回応用物理学会秋季学術講演会、2019 年 9 月

"PL および DLTS 測定による ZnSnP<sub>2</sub>バルク結晶の欠陥評価"
 <u>桑野太郎</u>、勝部涼司、Steve Johnston、Adele C. Tamboli、野瀬嘉太郎
 第81回応用物理学会秋季学術講演会、2020年9月

"ZnSnP2の M BE 成長における基板温度の影響"
 <u>桑野太郎</u>、野瀬嘉太郎
 第82回応用物理学会秋季学術講演会、2021年9月

# Award and Fellowship

京都大学教育研究振興財団 国際研究集会発表助成 (2019年6月)

京都大学工学研究科馬詰研究奨励賞 (2019年7月)

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